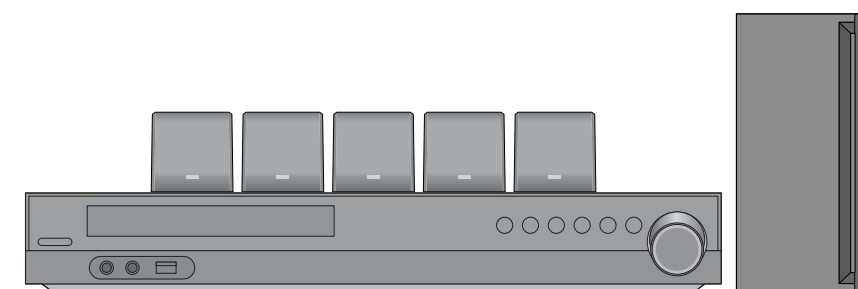




SERVICE MANUAL

MODEL : HT302SD(SH32SD-S/SH32SD-W)

# DVD/CD RECEIVER SERVICE MANUAL



**MODEL : HT302SD(SH32SD-S/SH32SD-W)**



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# SECTION 1. GENERAL

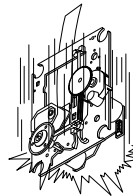
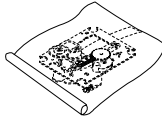
## SERVICING PRECAUTIONS

### NOTES REGARDING HANDLING OF THE PICK-UP

#### 1. Notes for transport and storage

- 1) The pick-up should always be left in its conductive bag until immediately prior to use.
- 2) The pick-up should never be subjected to external pressure or impact.

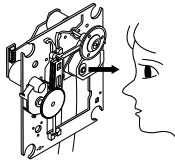
Storage in conductive bag



Drop impact

#### 2. Repair notes

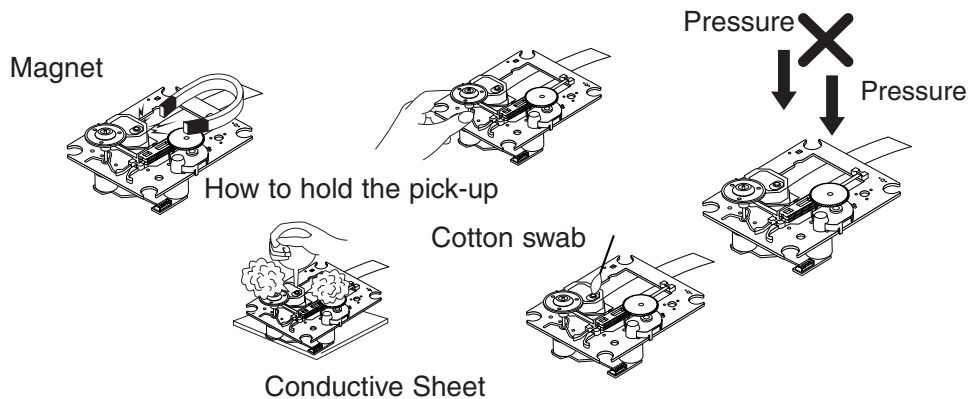
- 1) The pick-up incorporates a strong magnet, and so should never be brought close to magnetic materials.
- 2) The pick-up should always be handled correctly and carefully, taking care to avoid external pressure and impact. If it is subjected to strong pressure or impact, the result may be an operational malfunction and/or damage to the printed-circuit board.
- 3) Each and every pick-up is already individually adjusted to a high degree of precision, and for that reason the adjustment point and installation screws should absolutely never be touched.
- 4) Laser beams may damage the eyes!  
Absolutely never permit laser beams to enter the eyes!  
Also NEVER switch ON the power to the laser output part (lens, etc.) of the pick-up if it is damaged.



NEVER look directly at the laser beam, and don't let contact fingers or other exposed skin.

#### 5) Cleaning the lens surface

If there is dust on the lens surface, the dust should be cleaned away by using an air bush (such as used for camera lens). The lens is held by a delicate spring. When cleaning the lens surface, therefore, a cotton swab should be used, taking care not to distort this.



#### 6) Never attempt to disassemble the pick-up.

Spring by excess pressure. If the lens is extremely dirty, apply isopropyl alcohol to the cotton swab. (Do not use any other liquid cleaners, because they will damage the lens.) Take care not to use too much of this alcohol on the swab, and do not allow the alcohol to get inside the pick-up.

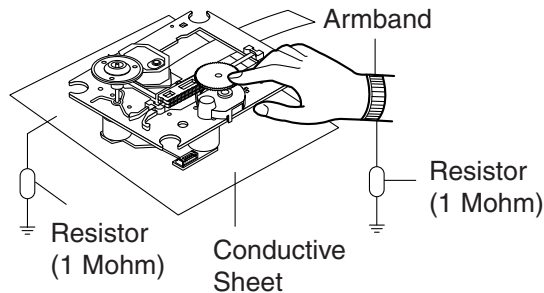
# NOTES REGARDING COMPACT DISC PLAYER REPAIRS

## 1. Preparations

- 1) Compact disc players incorporate a great many ICs as well as the pick-up (laser diode). These components are sensitive to, and easily affected by, static electricity. If such static electricity is high voltage, components can be damaged, and for that reason components should be handled with care.
- 2) The pick-up is composed of many optical components and other high-precision components. Care must be taken, therefore, to avoid repair or storage where the temperature or humidity is high, where strong magnetism is present, or where there is excessive dust.

## 2. Notes for repair

- 1) Before replacing a component part, first disconnect the power supply lead wire from the unit
- 2) All equipment, measuring instruments and tools must be grounded.
- 3) The workbench should be covered with a conductive sheet and grounded.  
When removing the laser pick-up from its conductive bag, do not place the pick-up on the bag. (This is because there is the possibility of damage by static electricity.)
- 4) To prevent AC leakage, the metal part of the soldering iron should be grounded.
- 5) Workers should be grounded by an armband (1M  $\Omega$ )
- 6) Care should be taken not to permit the laser pick-up to come in contact with clothing, in order to prevent static electricity charges in the clothing to escape from the armband.
- 7) The laser beam from the pick-up should NEVER be directly facing the eyes or bare skin.



# ESD PRECAUTIONS

## Electrostatically Sensitive Devices (ESD)



Some semiconductor (solid state) devices can be damaged easily by static electricity. Such components commonly are called Electrostatically Sensitive Devices (ESD). Examples of typical ESD devices are integrated circuits and some field-effect transistors and semiconductor chip components. The following techniques should be used to help reduce the incidence of component damage caused by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed for potential shock reasons prior to applying power to the unit under test.
2. After removing an electrical assembly equipped with ESD devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ESD devices.
4. Use only an anti-static solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ESD devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ESD devices.
6. Do not remove a replacement ESD device from its protective package until immediately before you are ready to install it. (Most replacement ESD devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive materials).
7. Immediately before removing the protective material from the leads of a replacement ESD device, touch the protective material to the chassis or circuit assembly into which the device will be installed.

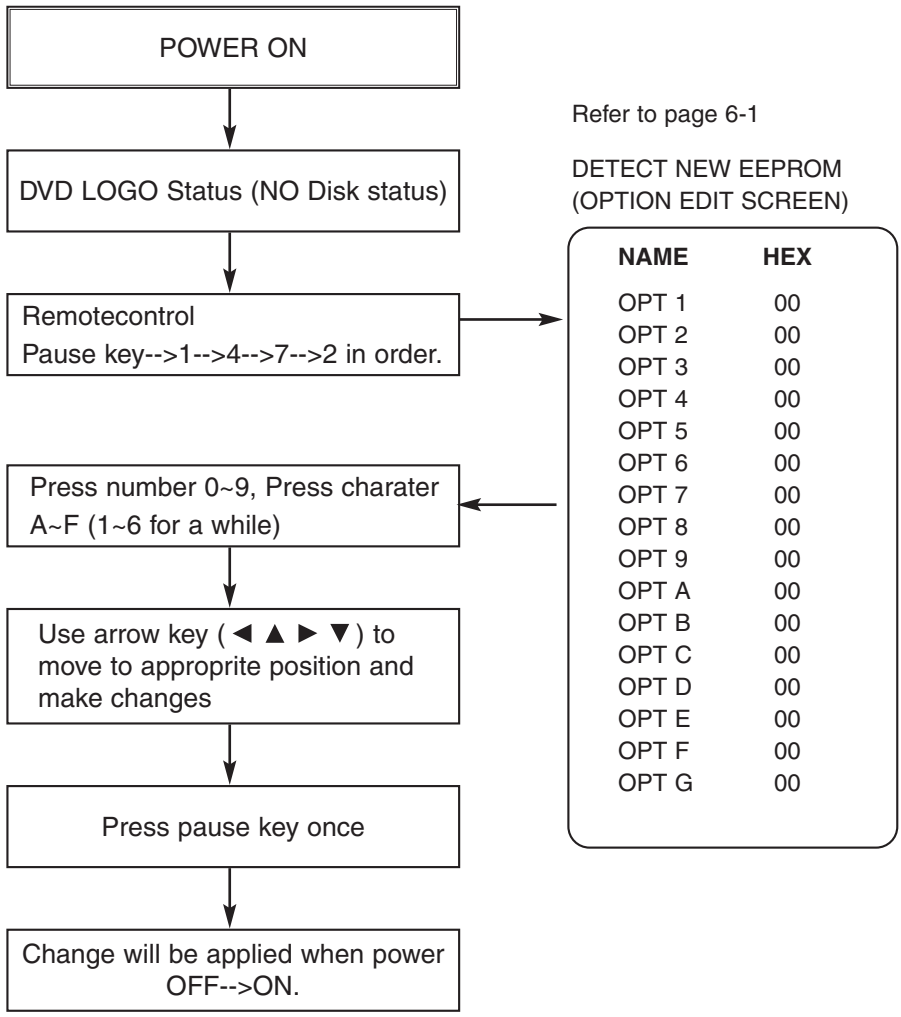
**CAUTION : BE SURE NO POWER IS APPLIED TO THE CHASSIS OR CIRCUIT, AND OBSERVE ALL OTHER SAFETY PRECAUTIONS.**

8. Minimize bodily motions when handling unpackaged replacement ESD devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ESD device).

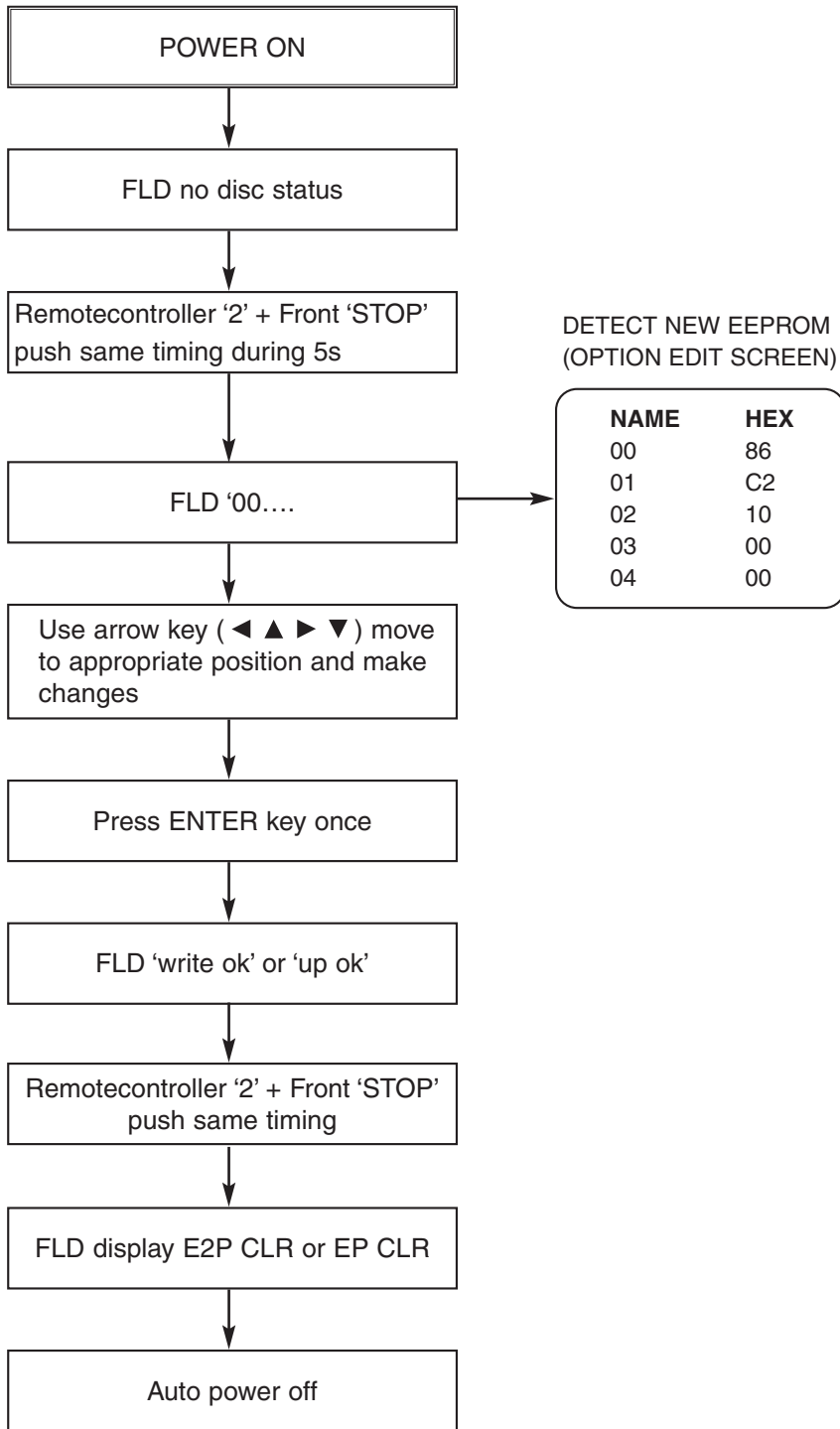
## CAUTION. GRAPHIC SYMBOLS

	THE LIGHTNING FLASH WITH APROWHEAD SYMBOL. WITHIN AN EQUILATERAL TRIANGLE, IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF UNINSULATED "DANGEROUS VOLTAGE" THAT MAY BE OF SUFFICIENT MAGNITUDE TO CONSTITUTE A RISK OF ELECTRIC SHOCK.
	THE EXCLAMATION POINT WITHIN AN EQUILATERAL TRIANGLE IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF IMPORTANT SAFETY INFORMATION IN SERVICE LITERATURE.

# SERVICE INFORMATION FOR EEPROM (DVD PART)



# SERVICE INFORMATION FOR EEPROM (MICOM PART)



# SPECIFICATIONS

## GENERAL

Power supply	Refer to main label
Power consumption	Refer to main label
Net Weight	2.4 kg
External dimensions (W x H x D)	360 x 63 x 307 mm
Operating conditions	Temperature: 5°C to 35°C, Operation status: Horizontal
Operating humidity	5% to 85%

## CD/DVD

Laser	Semiconductor laser, wavelength 650 nm
Signal system	PAL 625/50, NTSC 525/60
Frequency response (audio)	160 Hz to 18 kHz
Signal-to-noise ratio (audio)	More than 75 dB (1 kHz, NOP -6 dB, 20 kHz LPF/A-Filter)
Dynamic range (audio)	More than 70 dB
Harmonic distortion (audio)	0.5 % (1 kHz, at 1W position) (20 kHz LPF)

## VIDEO

Video output	1.0 V (p-p), 75 Ω, negative sync./ SCART (TO TV)
COMPONENT VIDEO OUT	(Y) 1.0 V (p-p), 75 ohms, negative sync, RCA jack x 1 (Pb)/(Pr) 0.7 V (p-p), 75 ohms, RCA jack x 1

## TUNER

### FM

Tuning Range	87.5 - 108.0 MHz or 65.0 - 74.0 MHz, 87.5 - 108.0 MHz
Intermediate Frequency	10.7 MHz
Signal-to Noise Ratio	60 dB (Mono)
Frequency Response	160 - 8,000 Hz

### AM [MW]

Tuning Range	522 - 1,620 kHz or 520 - 1,720 kHz
Intermediate Frequency	450 kHz

## AMPLIFIER

Stereo mode	45W + 45W (Rated Output Power 30W, 4at 1 kHz, THD 10 %)
Surround mode	Front: 45W + 45W (Rated Output Power 30W, THD 10 %) Centre*: 45W Surround*: 45W + 45W (Rated Output Power 30W, 4at 1 kHz, THD 10 %) Subwoofer*: 75W (Rated Output Power 60W, 8at 30 Hz, THD 10 %)
(* Depending on the sound mode settings and the source, there may be no sound output.)	
Inputs	AUX IN, MIC

## SPEAKERS

	Front/Center/Rear Speaker	Passive Subwoofer
Type	(SH32SD-S) 1 Way1 Speaker	(SH32SD-W) 1 Way1 Speaker
Impedance	4 Ω	8 Ω
Frequency Response	160 - 20,000	Hz 65 - 1,500 Hz
Sound Pressure Level	84 dB/W (1m)	87 dB/W (1m)
Rated Input Power	45 W	75 W
Max. Input Power	90 W	150 W
Net Dimensions (W x H x D)	98 x 101 x 105 mm	181 x 351 x 278 mm
Net Weight	0.52kg	3.4kg



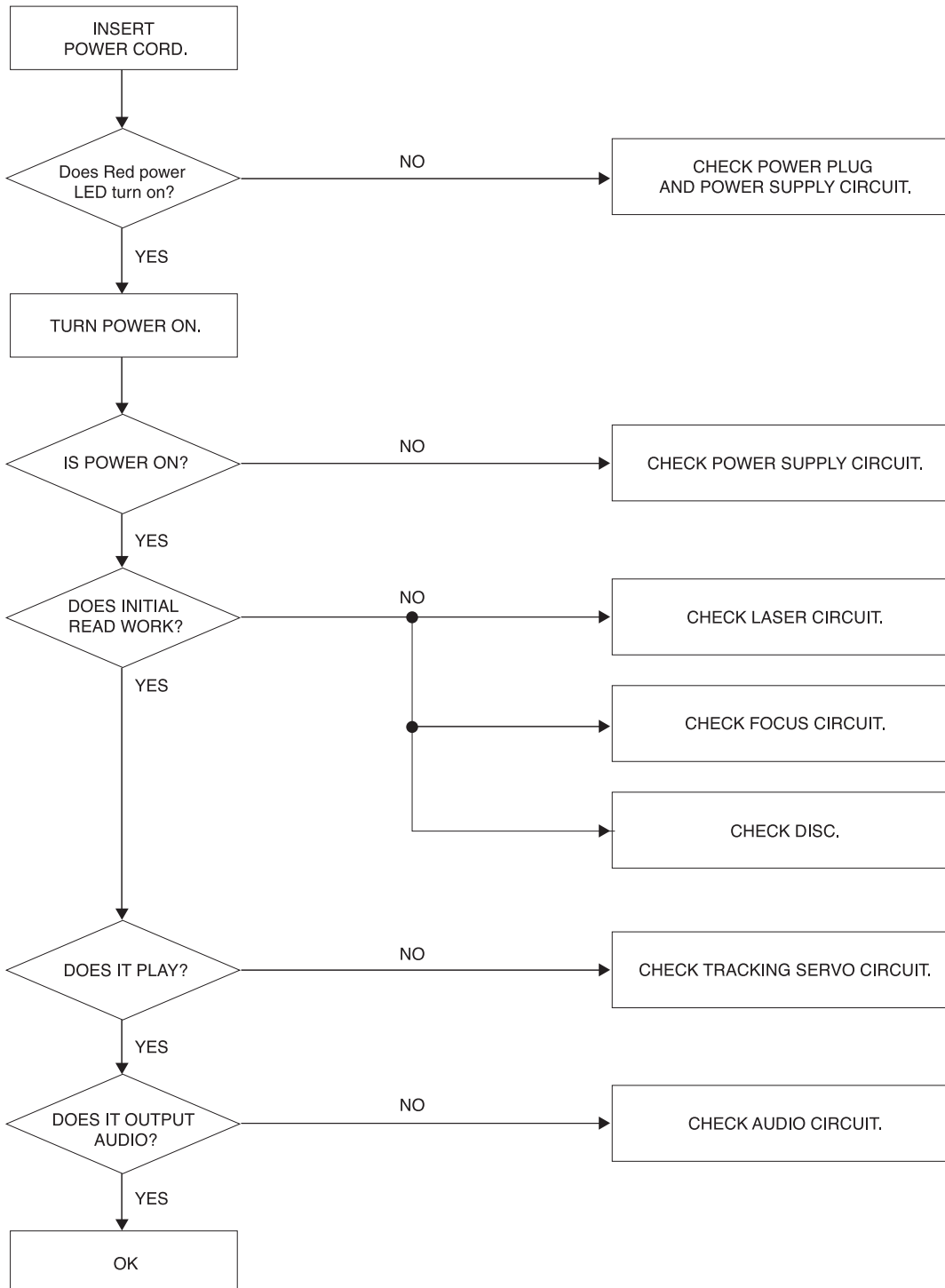
**MEMO**

A series of horizontal dotted lines for writing.

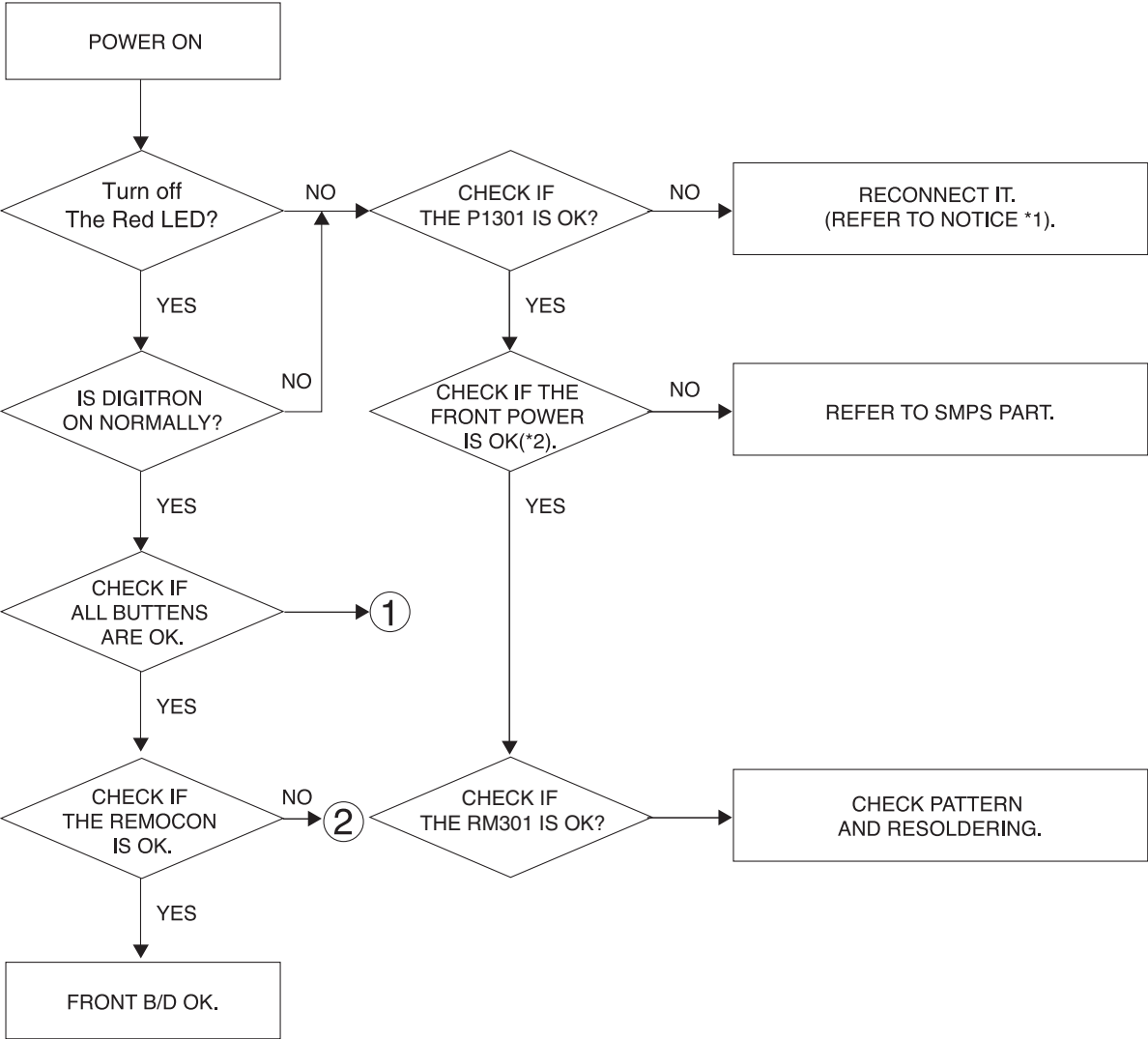
# SECTION 2. AUDIO PART

## AUDIO TROUBLESHOOTING GUIDE

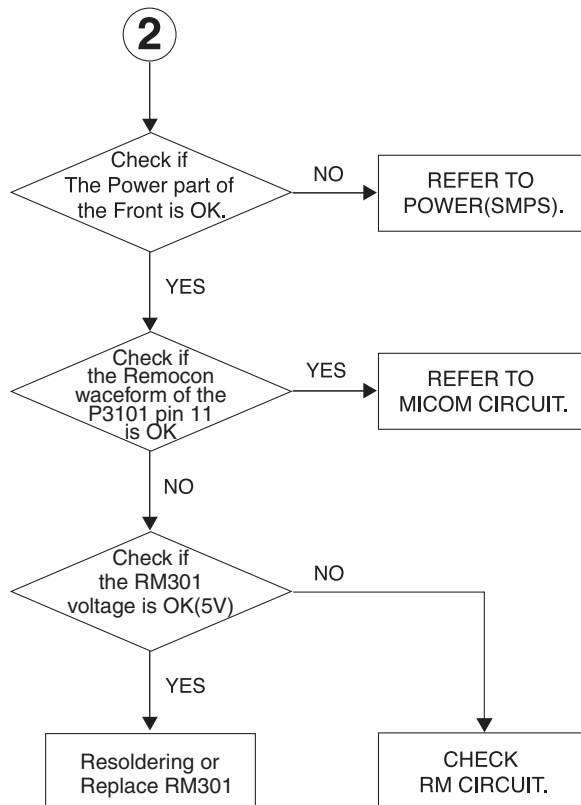
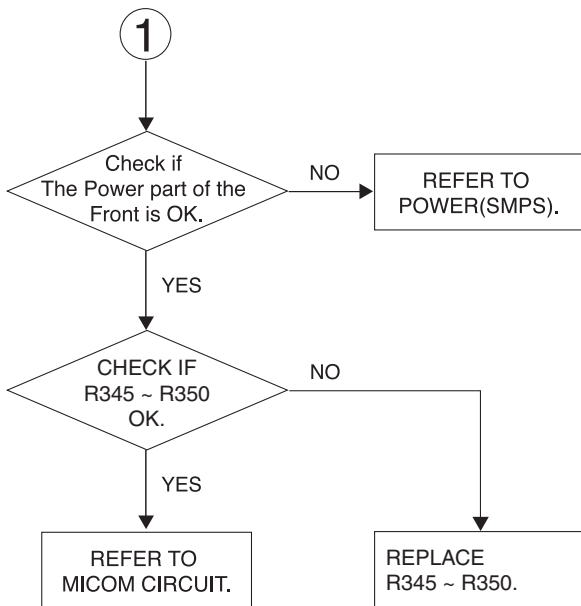
### 1. POWER SUPPLY CIRCUIT



# 2. FRONT CIRCUIT (1/2)



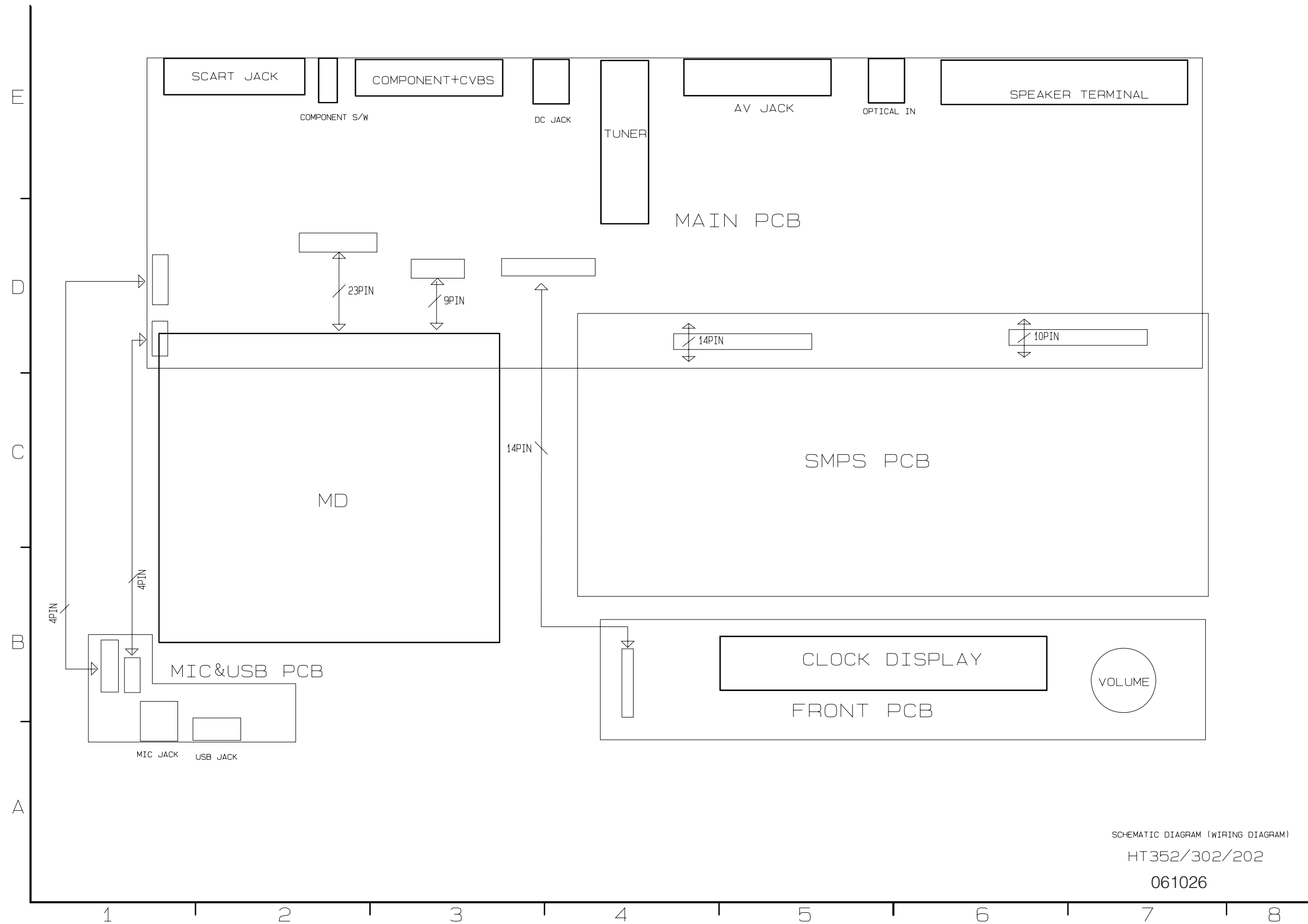
### 3. FRONT CIRCUIT (2/2)



# MEMO

A series of horizontal dotted lines providing a template for writing a memo.

# WIRING DIAGRAM

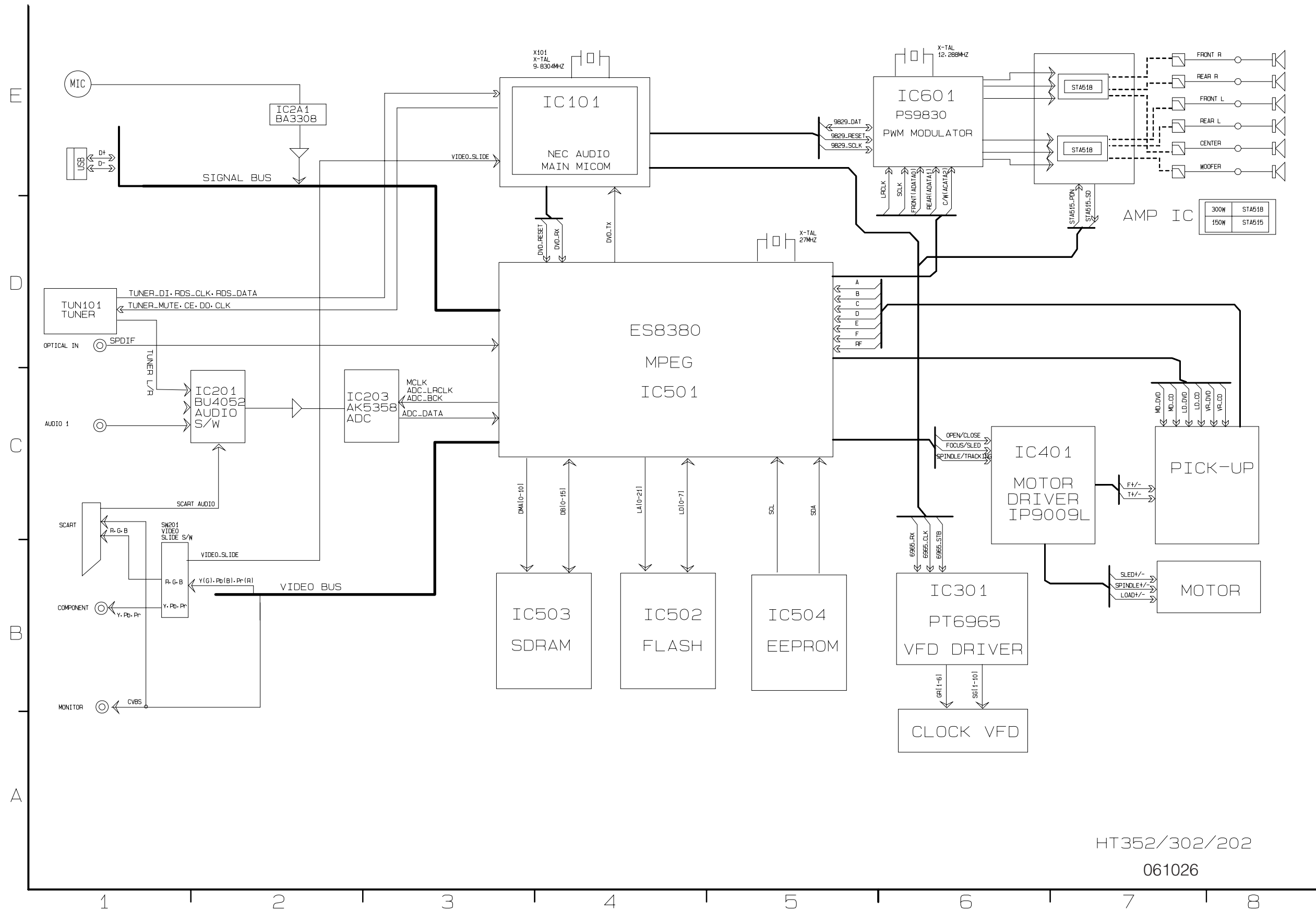


SCHEMATIC DIAGRAM (WIRING DIAGRAM)

HT352/302/202

061026

# BLOCK DIAGRAM

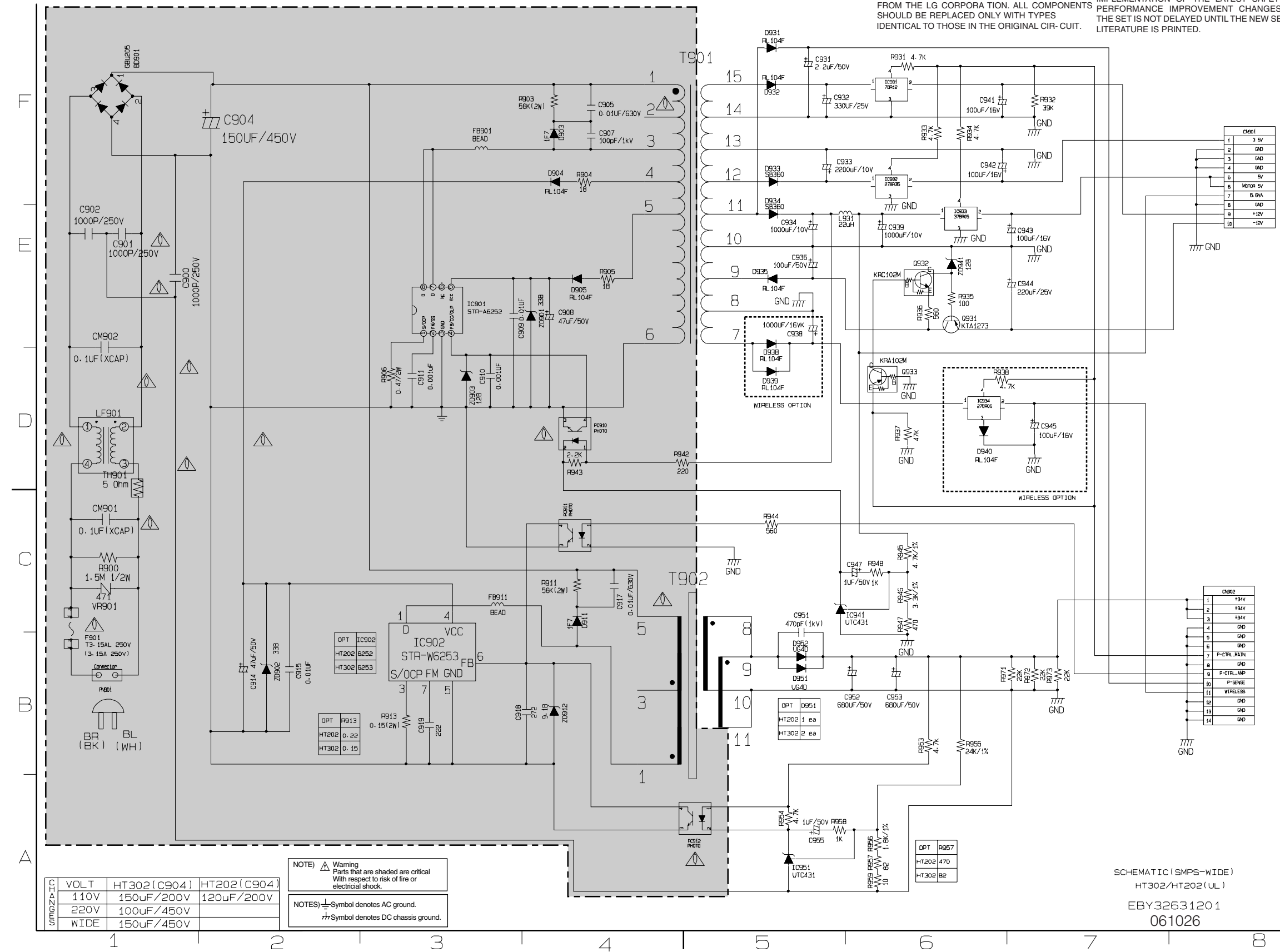


HT352/302/202

061026

# CIRCUIT DIAGRAMS

## 1. SMPS(POWER) CIRCUIT DIAGRAM



### IMPORTANT SAFETY NOTICE

WHEN SERVICING THIS CHASSIS, UNDER NO CIRCUMSTANCES SHOULD THE ORIGINAL DESIGN BE MODIFIED OR ALTERED WITHOUT PERMISSION FROM THE LG CORPORATION. ALL COMPONENTS SHOULD BE REPLACED ONLY WITH TYPES IDENTICAL TO THOSE IN THE ORIGINAL CIRCUIT.

### SPECIAL COMPONENTS ARE SHADED ON THE SCHEMATIC FOR EASY IDENTIFICATION.

THIS CIRCUIT DIAGRAM MAY OCCASIONALLY DIFFER FROM THE ACTUAL CIRCUIT USED. THIS WAY, IMPLEMENTATION OF THE LATEST SAFETY AND PERFORMANCE IMPROVEMENT CHANGES INTO THE SET IS NOT DELAYED UNTIL THE NEW SERVICE LITERATURE IS PRINTED.

### NOTE :

1. Shaded parts are critical for safety. Replace only with specified part number.
2. Voltages are DC-measured with a digital voltmeter during Play mode.

UM10GZ-LC	VOLT	HT302 (C904)	HT202 (C904)
	110V	150uF/200V	120uF/200V
	220V	100uF/450V	
	WIDE	150uF/450V	

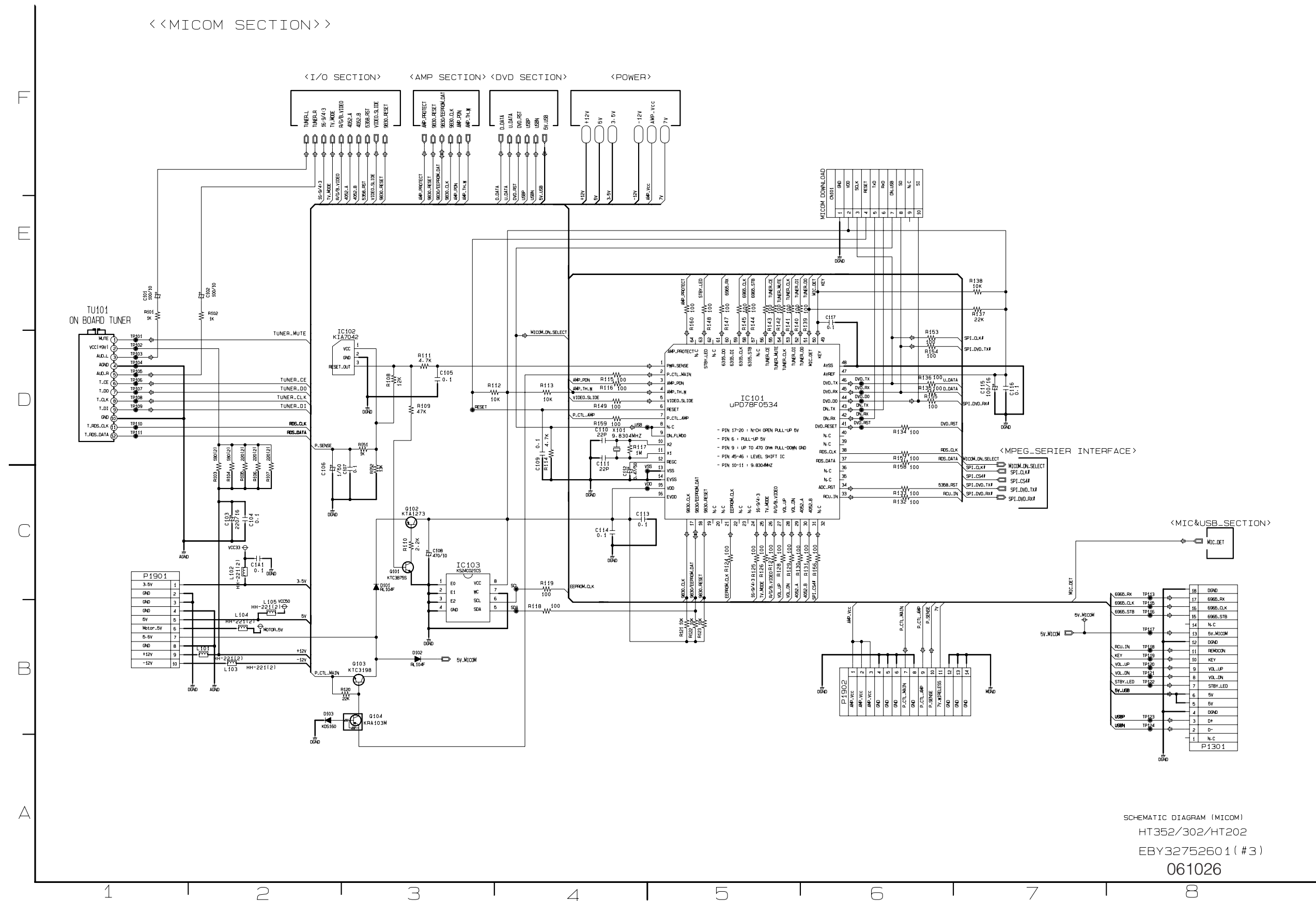
NOTE) Warning Parts that are shaded are critical With respect to risk of fire or electrical shock.

NOTES) Symbol denotes AC ground.  
 Symbol denotes DC chassis ground.

SCHEMATIC (SMPS-WIDE)  
 HT302/HT202 (UL)  
 EBY32631201  
 061026

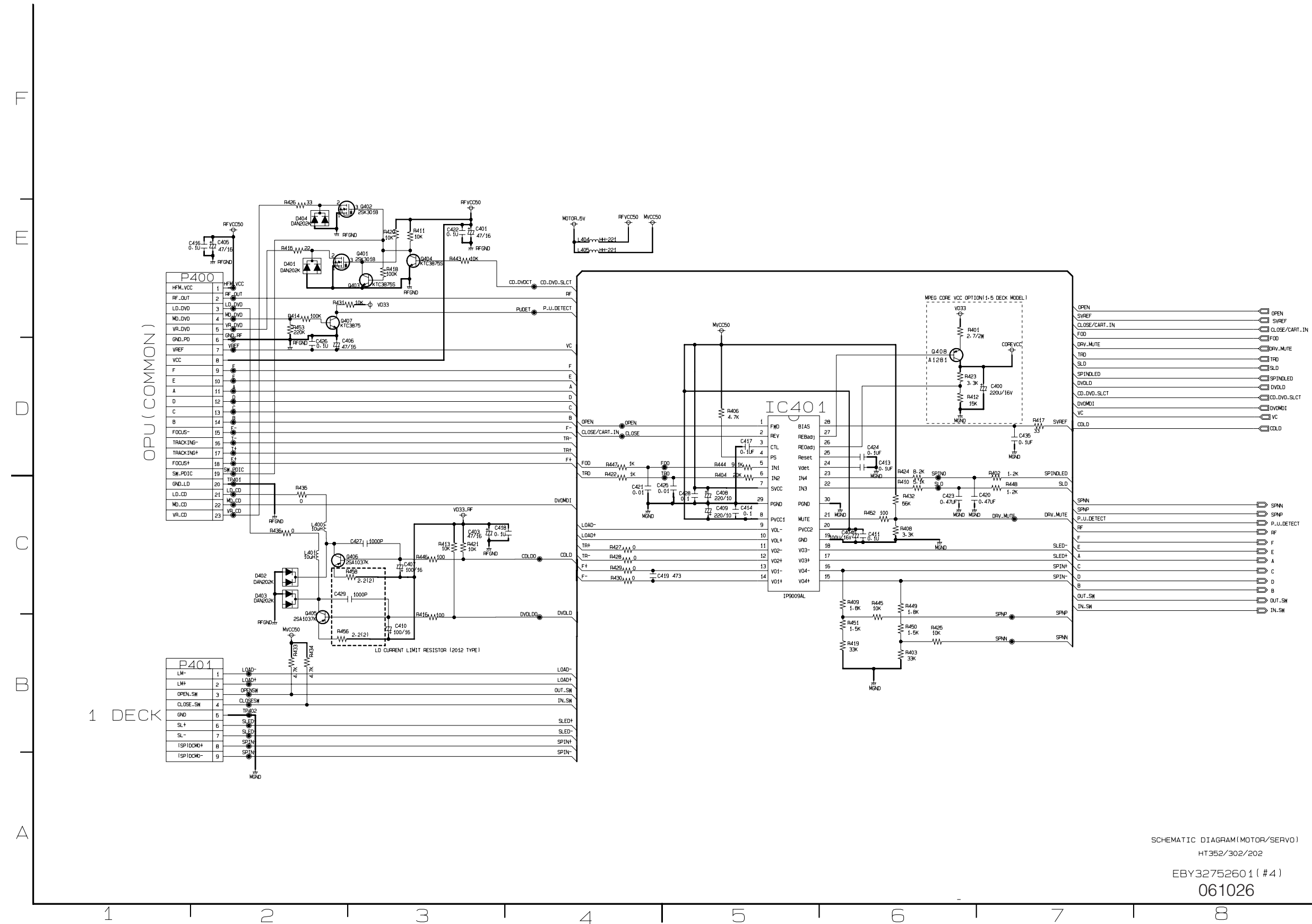


## 2. $\mu$ -COM(MAIN) CIRCUIT DIAGRAM



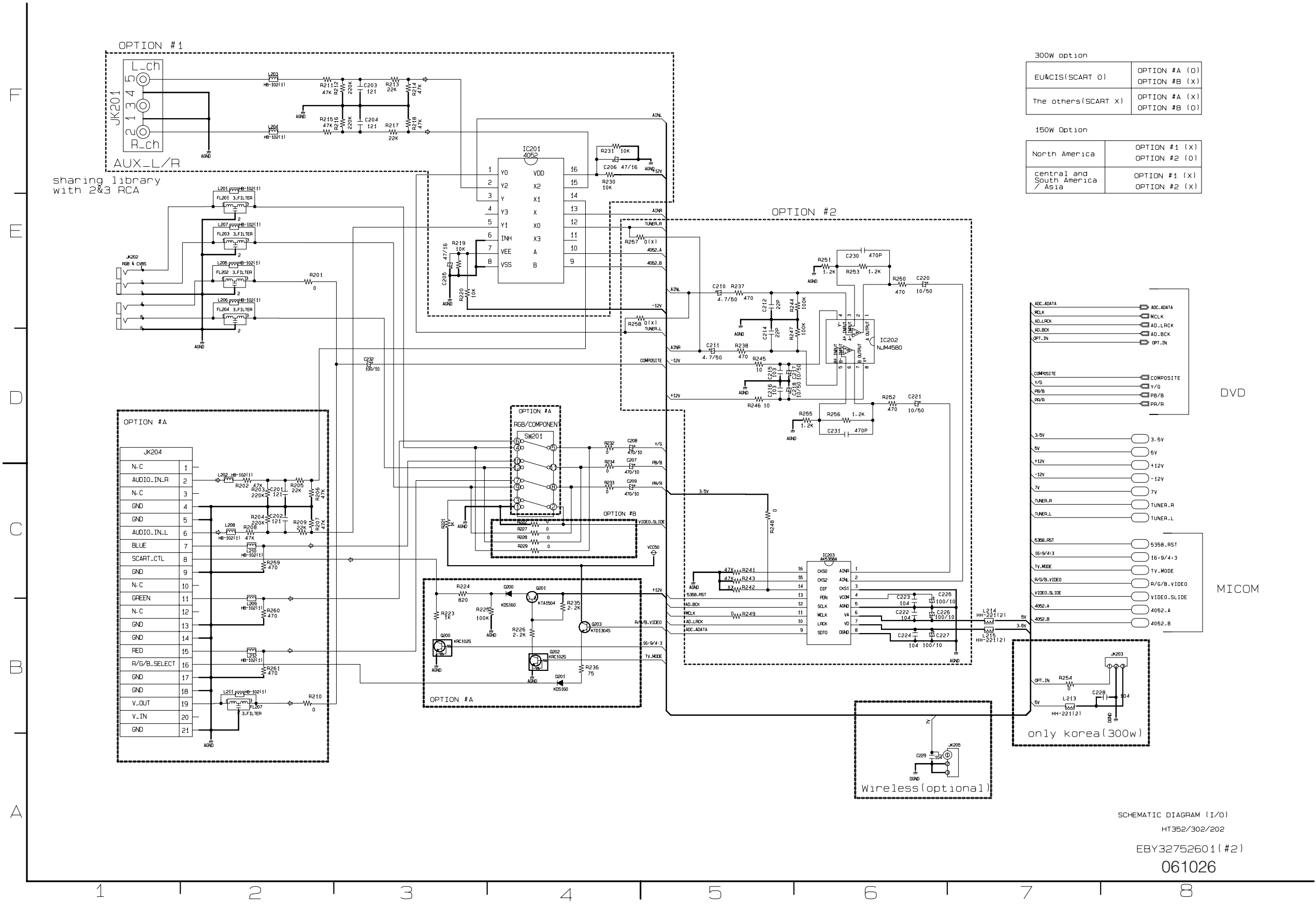
SCHEMATIC DIAGRAM (MICOM)  
HT352/302/HT202  
EBY32752601 (#3)  
061026

### 3. MOTOR & SERVO CIRCUIT DIAGRAM



SCHMATIC DIAGRAM (MOTOR/SERVO)  
 HT352/302/202  
 EBY32752601 (#4)  
 061026

# 4. I/O CIRCUIT DIAGRAM

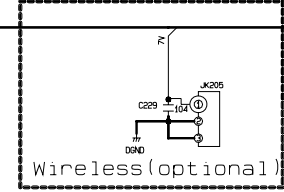
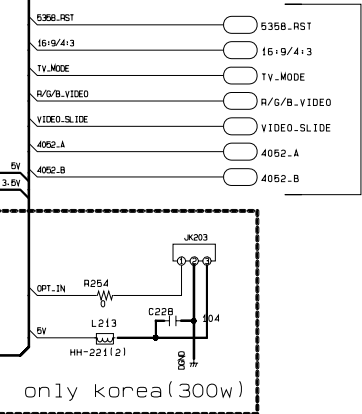
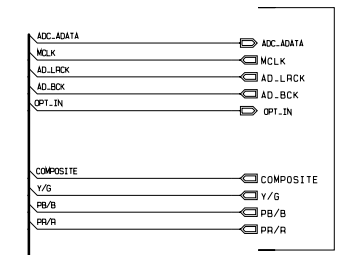


300w option

EU&CIS(SCART 0)	OPTION #A (O)
	OPTION #B (X)
The others(SCART X)	OPTION #A (X)
	OPTION #B (O)

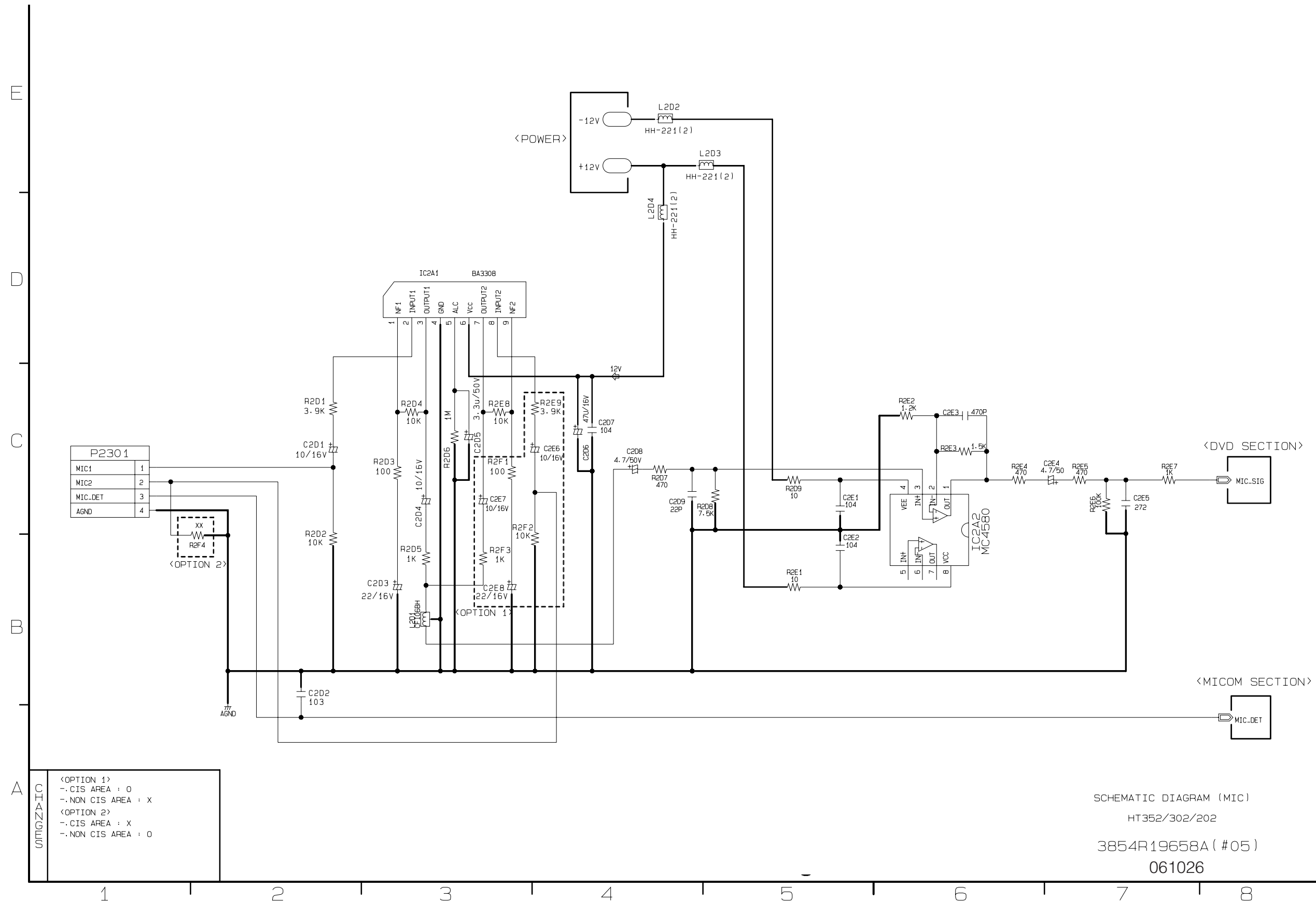
150W Option

North America	OPTION #1 (X)
	OPTION #2 (O)
central and South America / Asia	OPTION #1 (X)
	OPTION #2 (X)



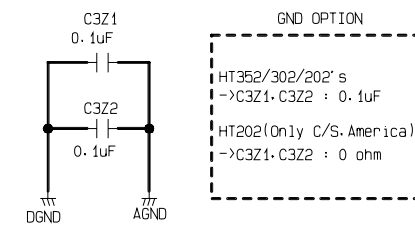
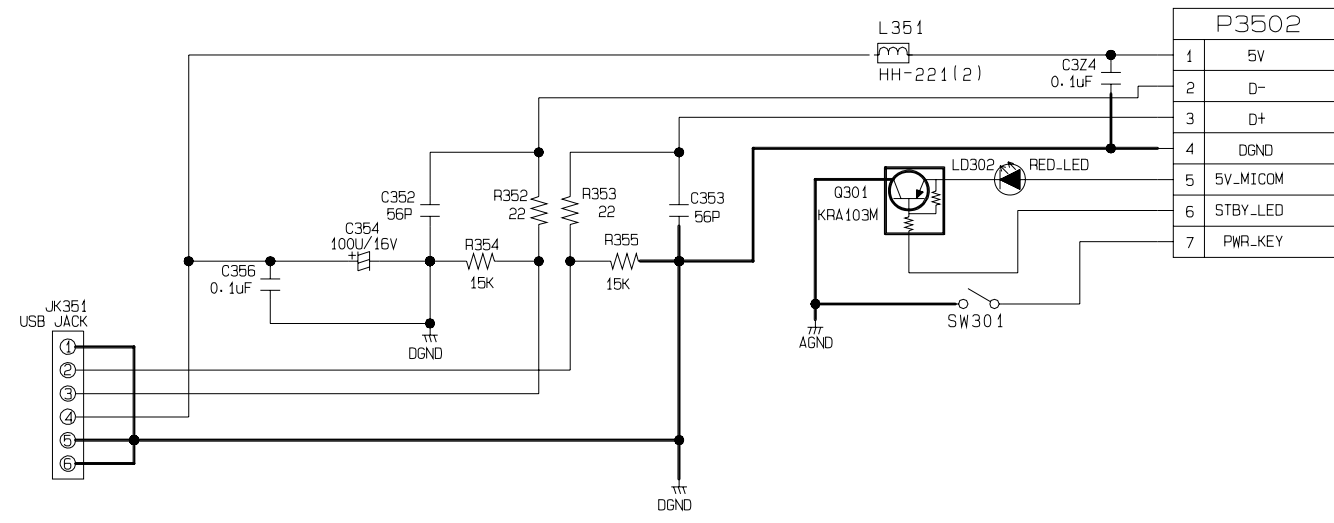
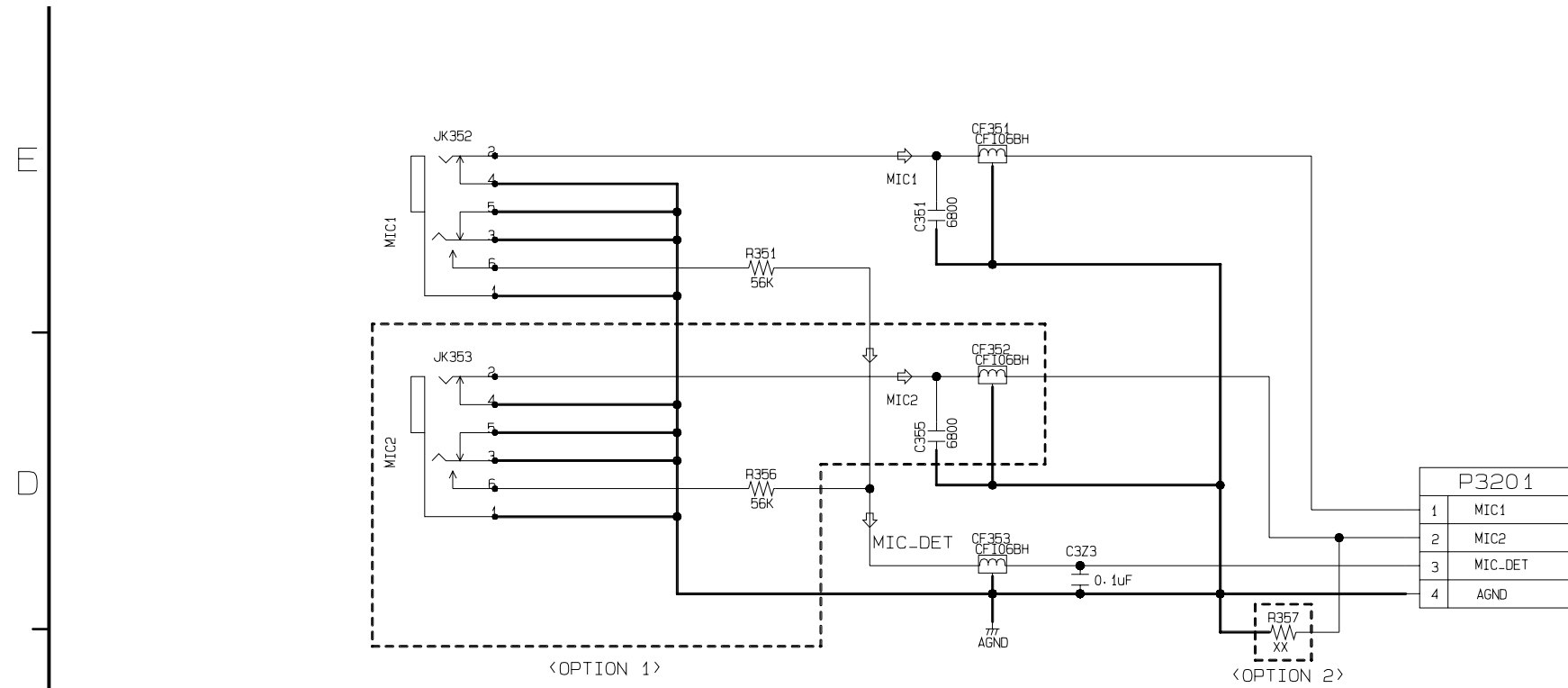
SCHMATIC DIAGRAM (I/O)  
HT352/302/202  
EBY32752601(#2)  
061026

# 5. MIC CIRCUIT DIAGRAM



SCHMATIC DIAGRAM (MIC)  
 HT352/302/202  
 3854R19658A (#05)  
 061026

## 6. FRONT JACK CIRCUIT DIAGRAM

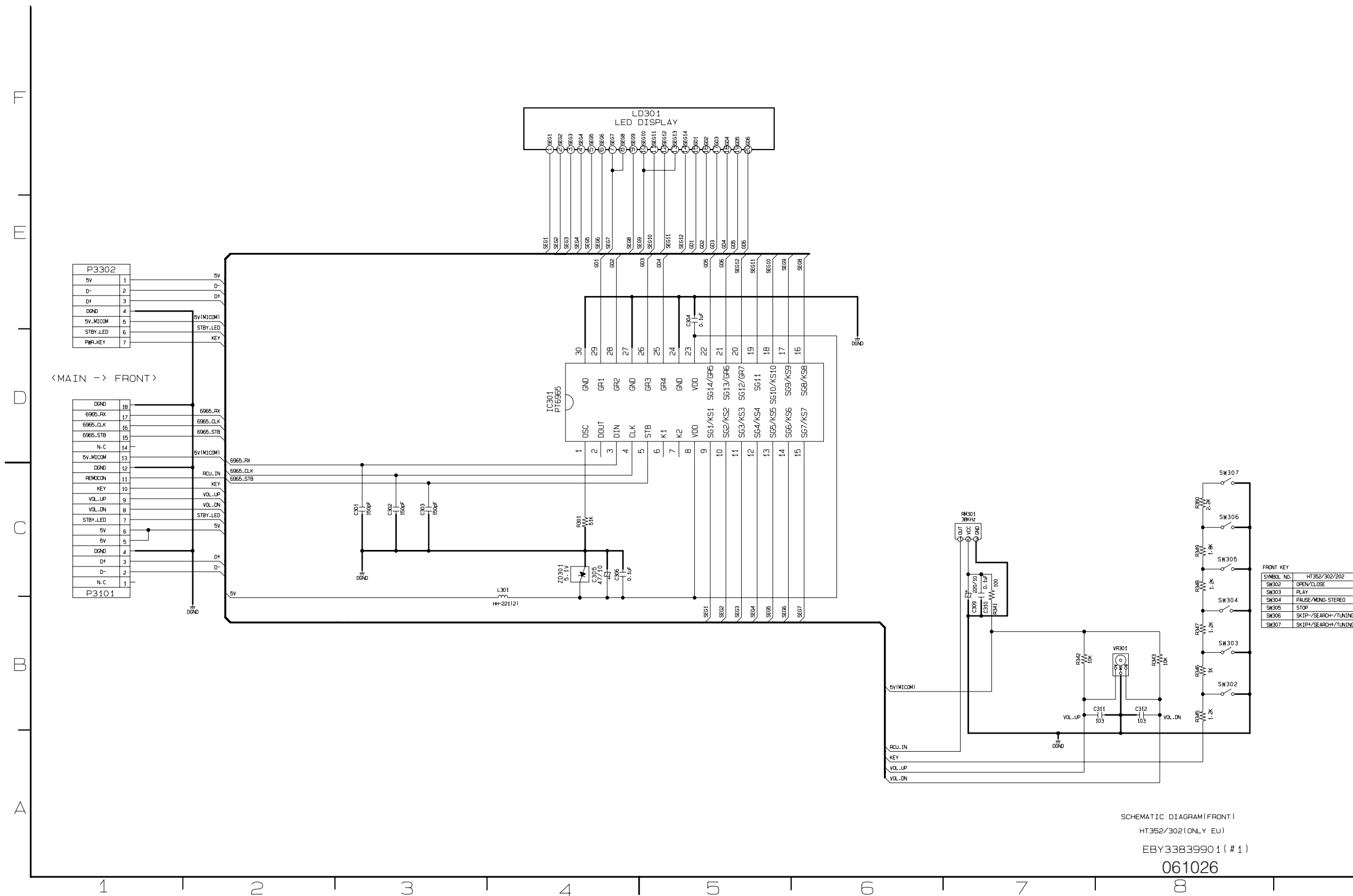


SCHMATIC DIAGRAM (MIC/USB JACK)  
HT302/202

EBY32752901(#1)  
061026

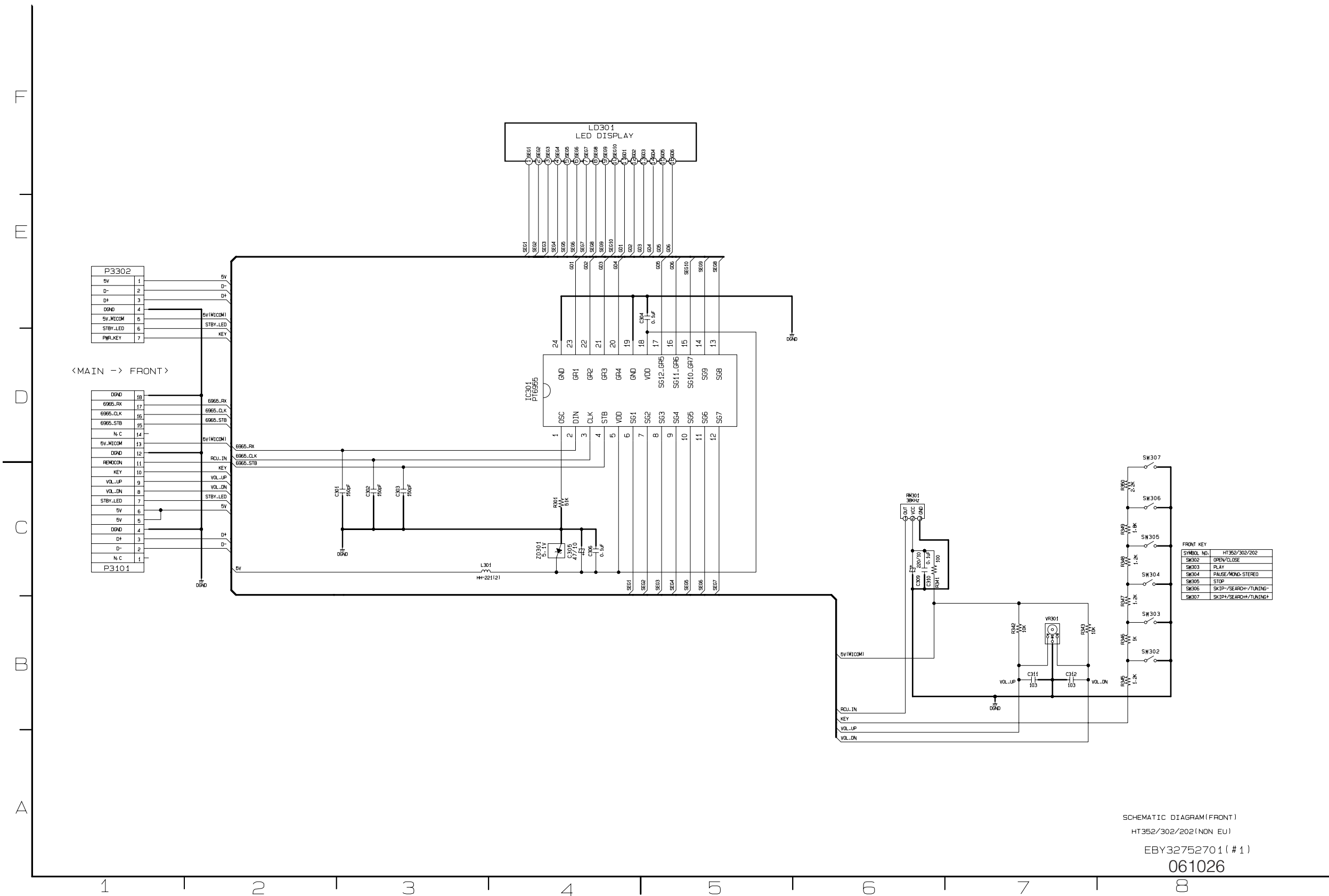
OPTION 1  
-. CIS AREA : 0  
-. NON CIS AREA : X  
OPTION 2  
-. CIS AREA : OPEN  
-. NON CIS AREA : 0 Ohm

# 7. FRONT CIRCUIT DIAGRAM(WITH RDS)



SCHMATIC DIAGRAM(FRONT)  
HT352/302(ONLY EU)  
EBY33839901 (# 1)  
061026

# 8. FRONT CIRCUIT DIAGRAM(WITHOUT RDS)

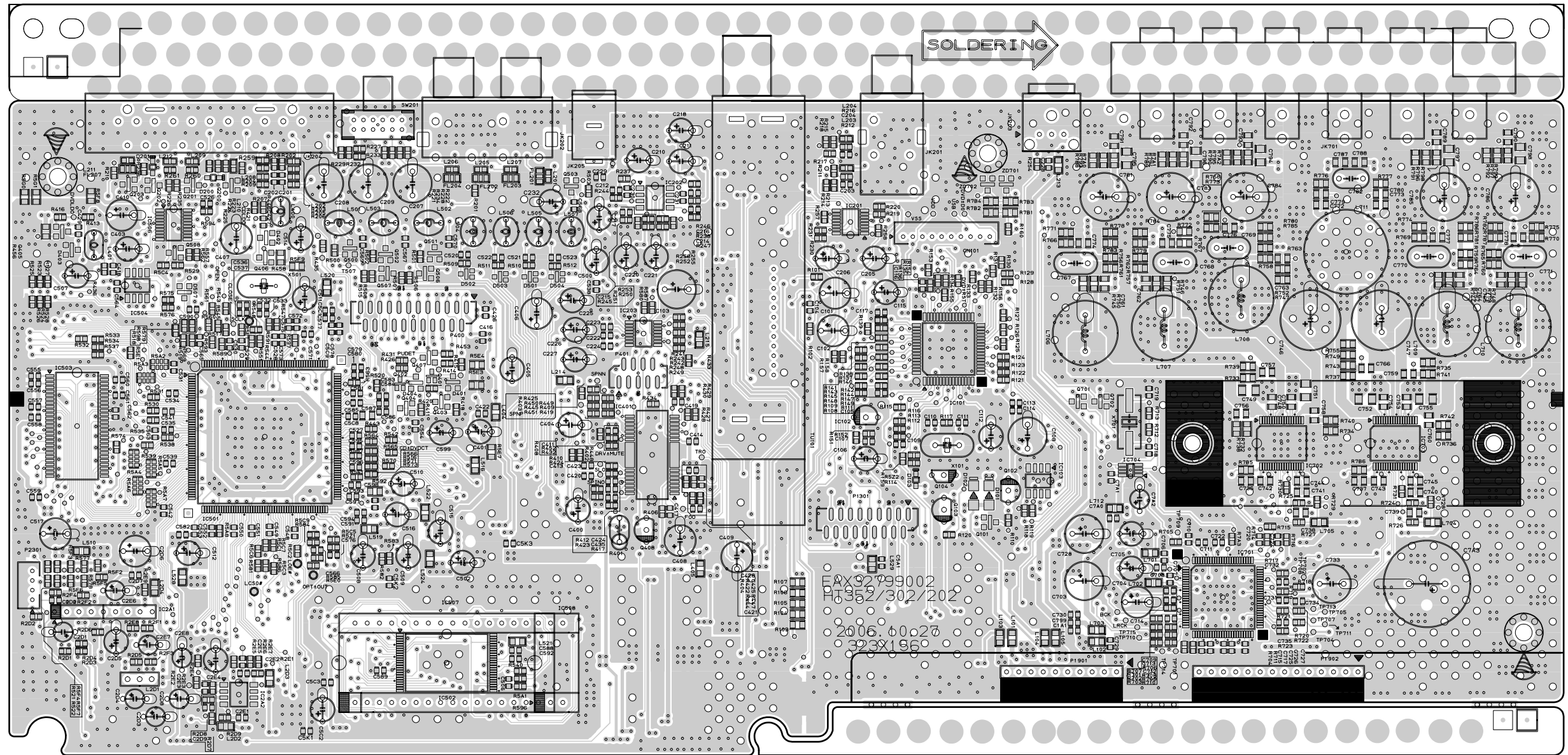


SCHEMATIC DIAGRAM(FRONT)  
HT352/302/202(NON EU)

EBY32752701(#1)  
061026

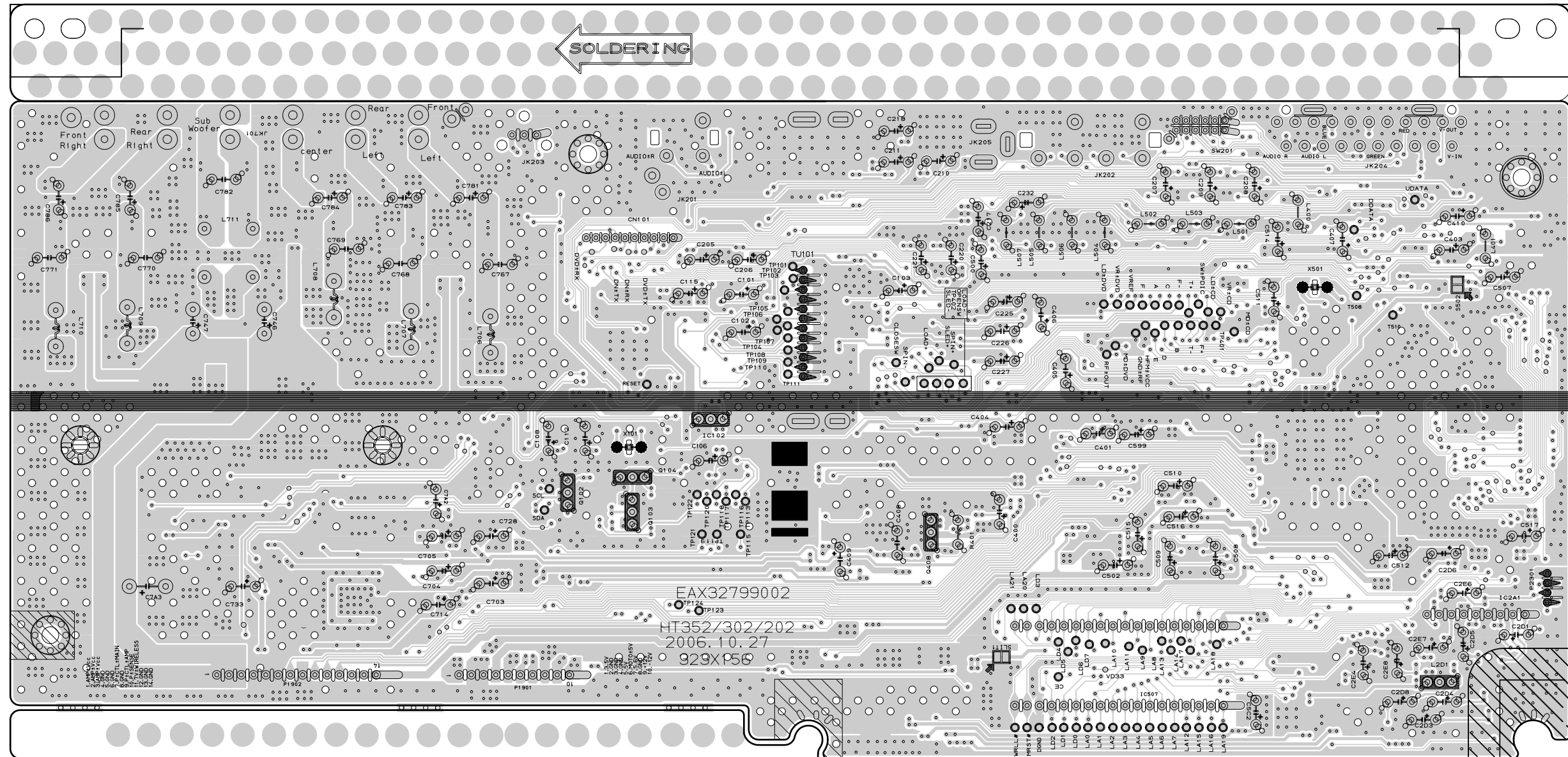
# PRINTED CIRCUIT BOARD DIAGRAMS

## 1. MAIN P.C. BOARD DIAGRAM ( TOP VIEW )

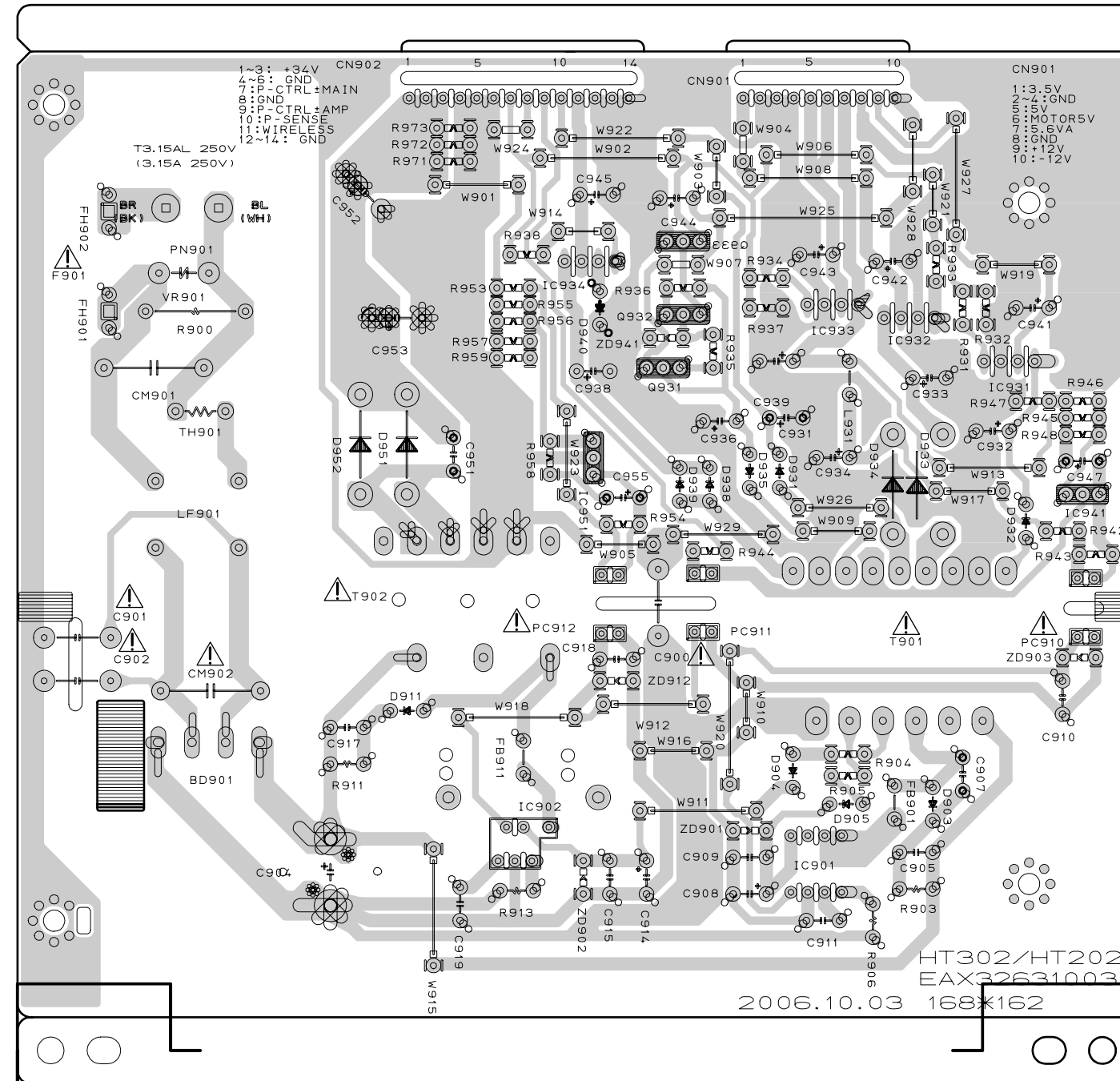




## 2. MAIN P.C. BOARD DIAGRAM ( BOTTOM VIEW )

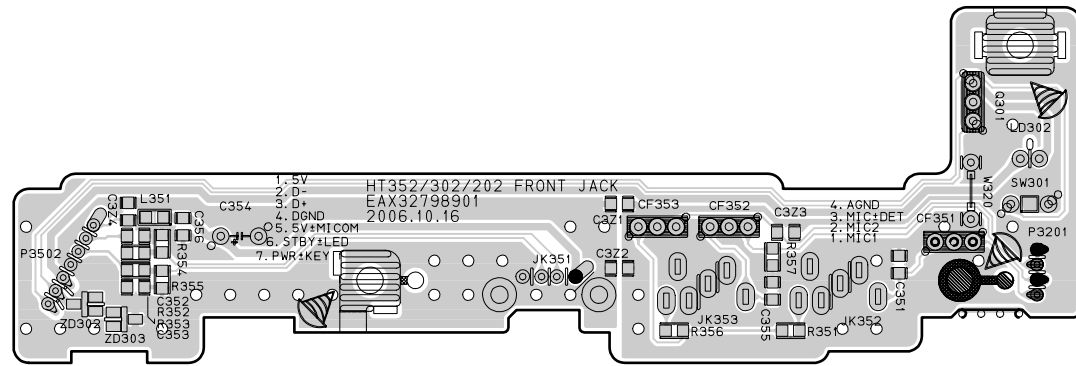


### 3. SMPS P.C. BOARD

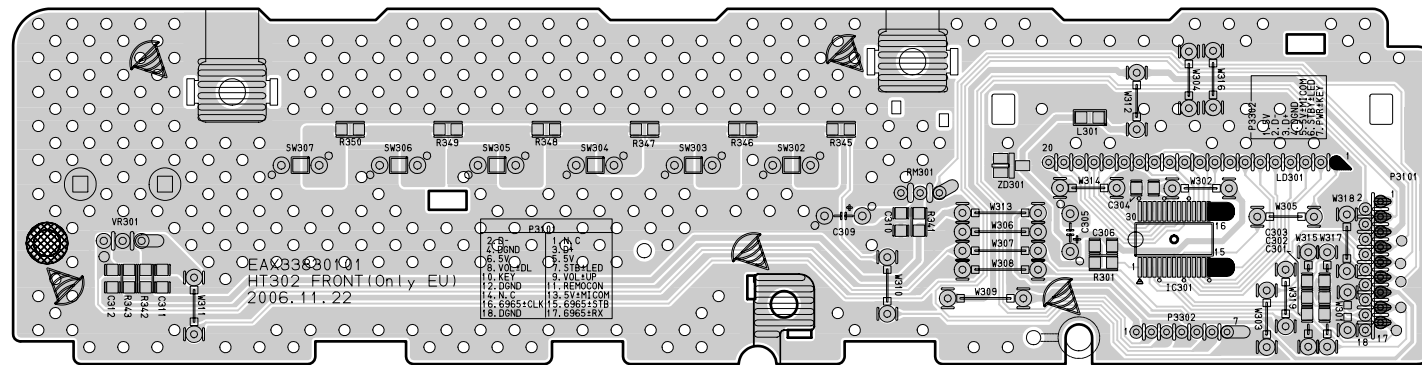


**NOTE: Warning**  
 ⚠ Parts that are shaded are critical With respect to risk of fire or electrical shock.

#### 4. FRONT JACK P.C BOARD



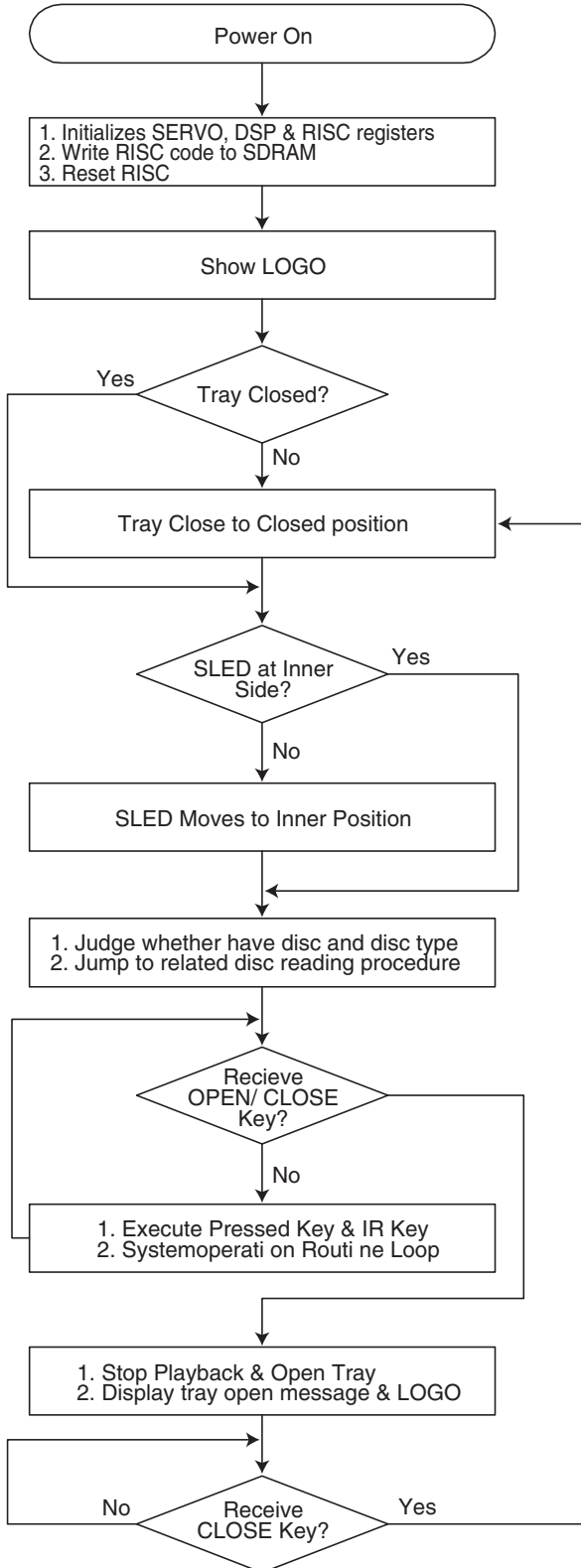
#### 5. FRONT P.C. BOARD(WITH RDS)



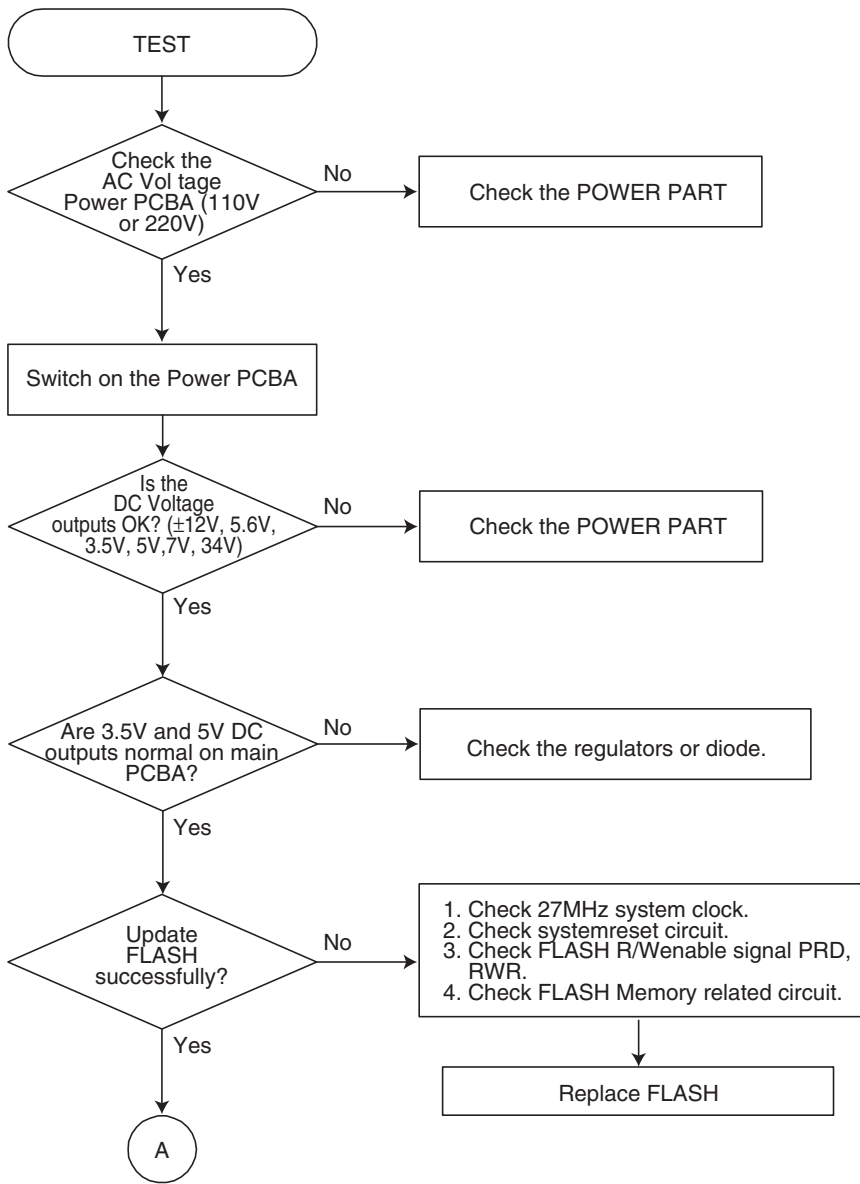
# SECTION 3. DVD & AMP PART

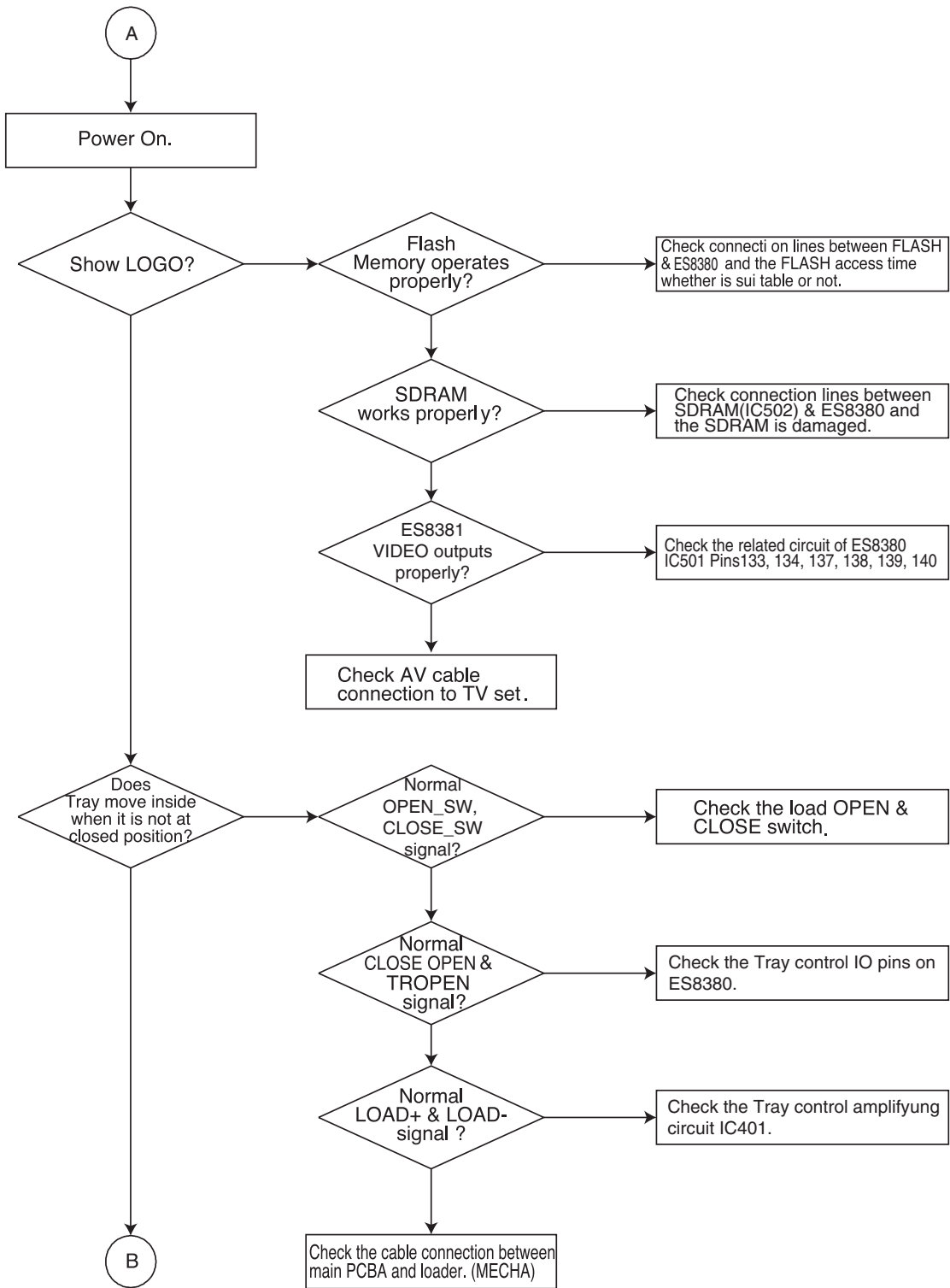
## ELECTRICAL TROUBLESHOOTING GUIDE

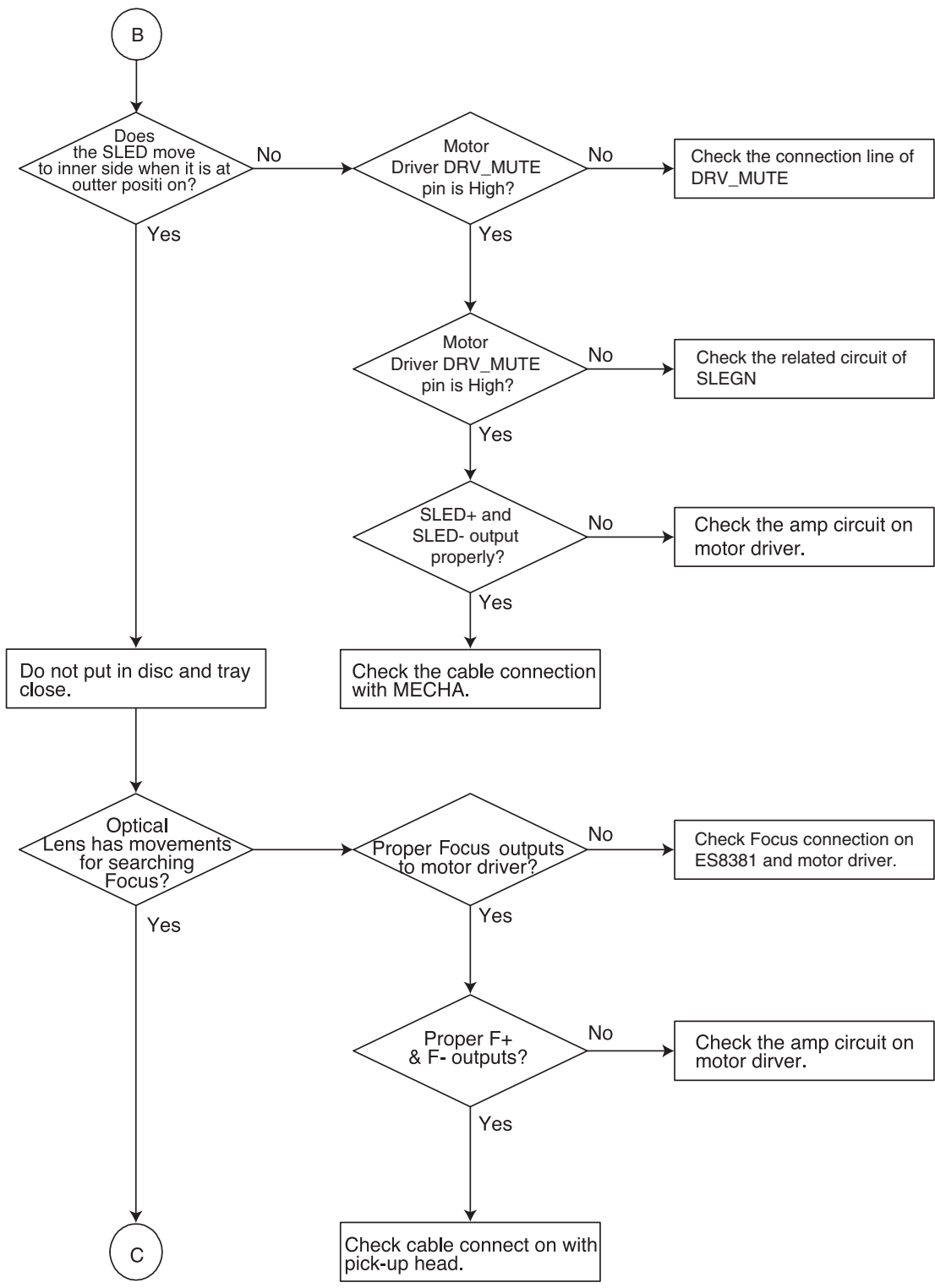
### 1. System operation flow

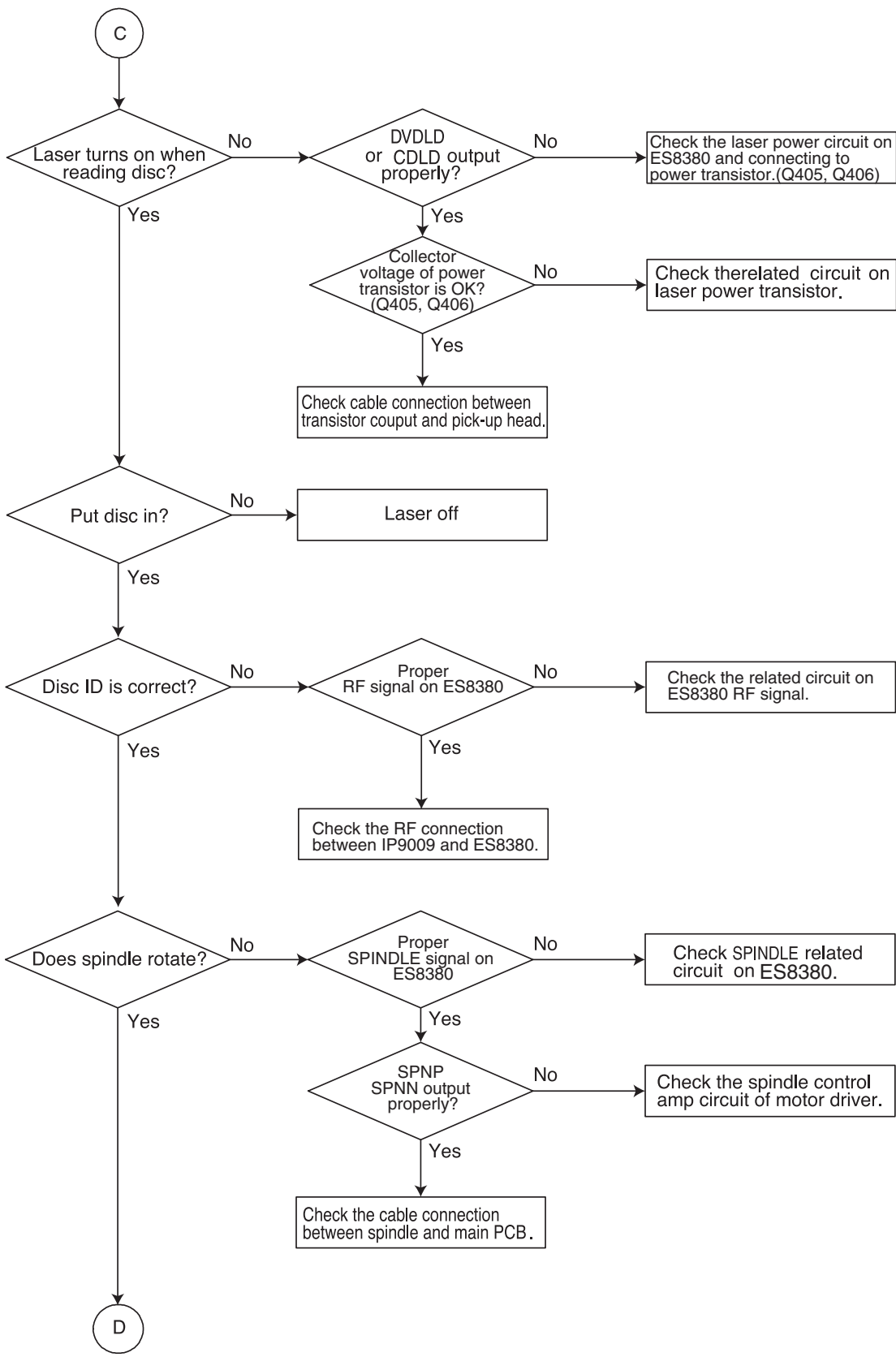


## 2. Test & debug flow

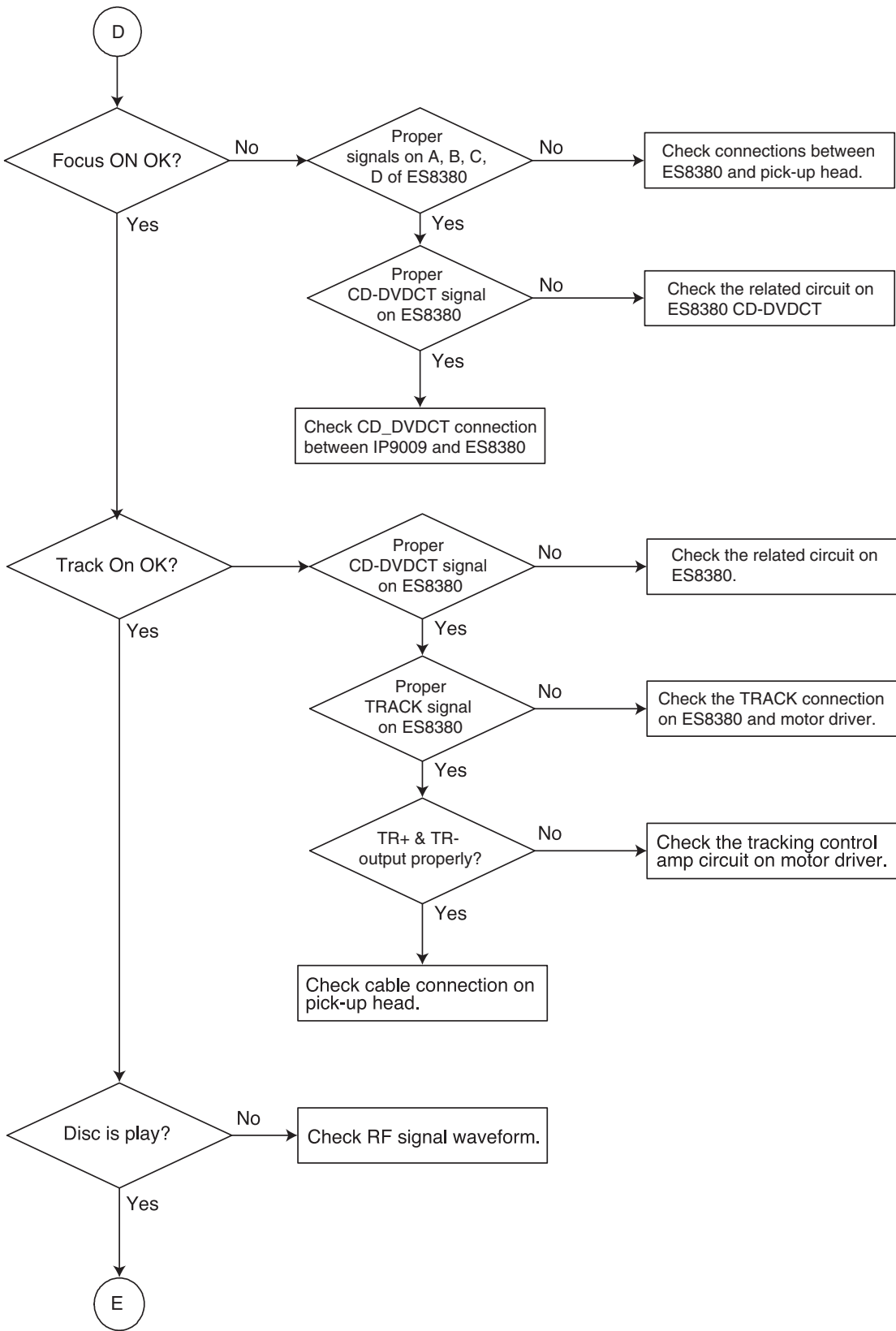


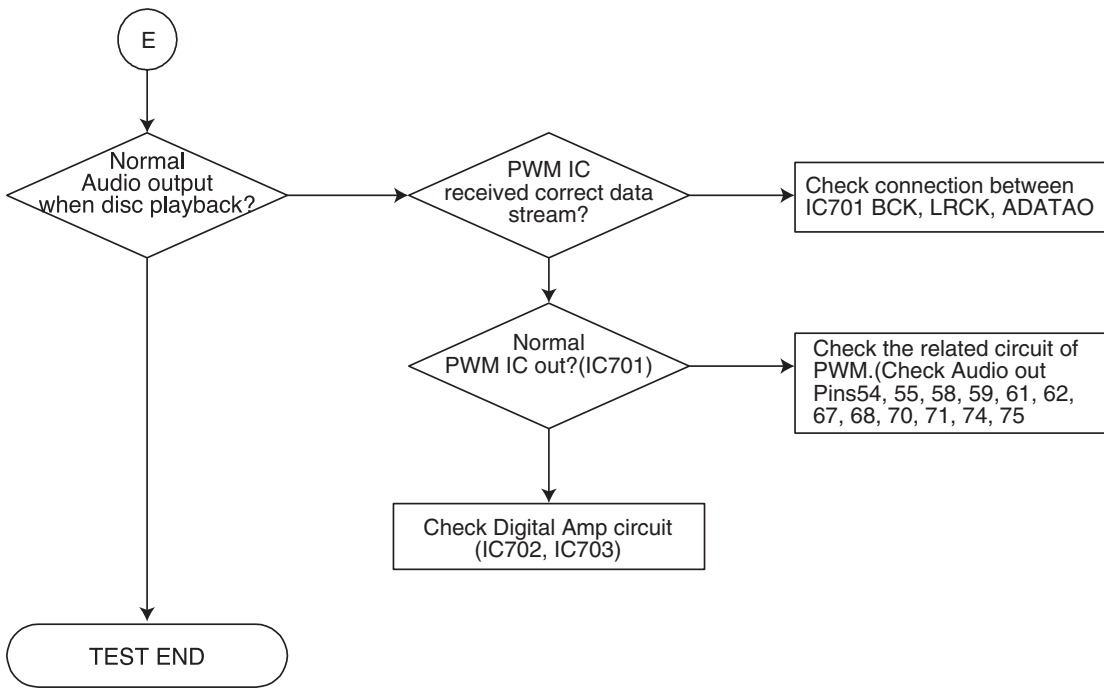




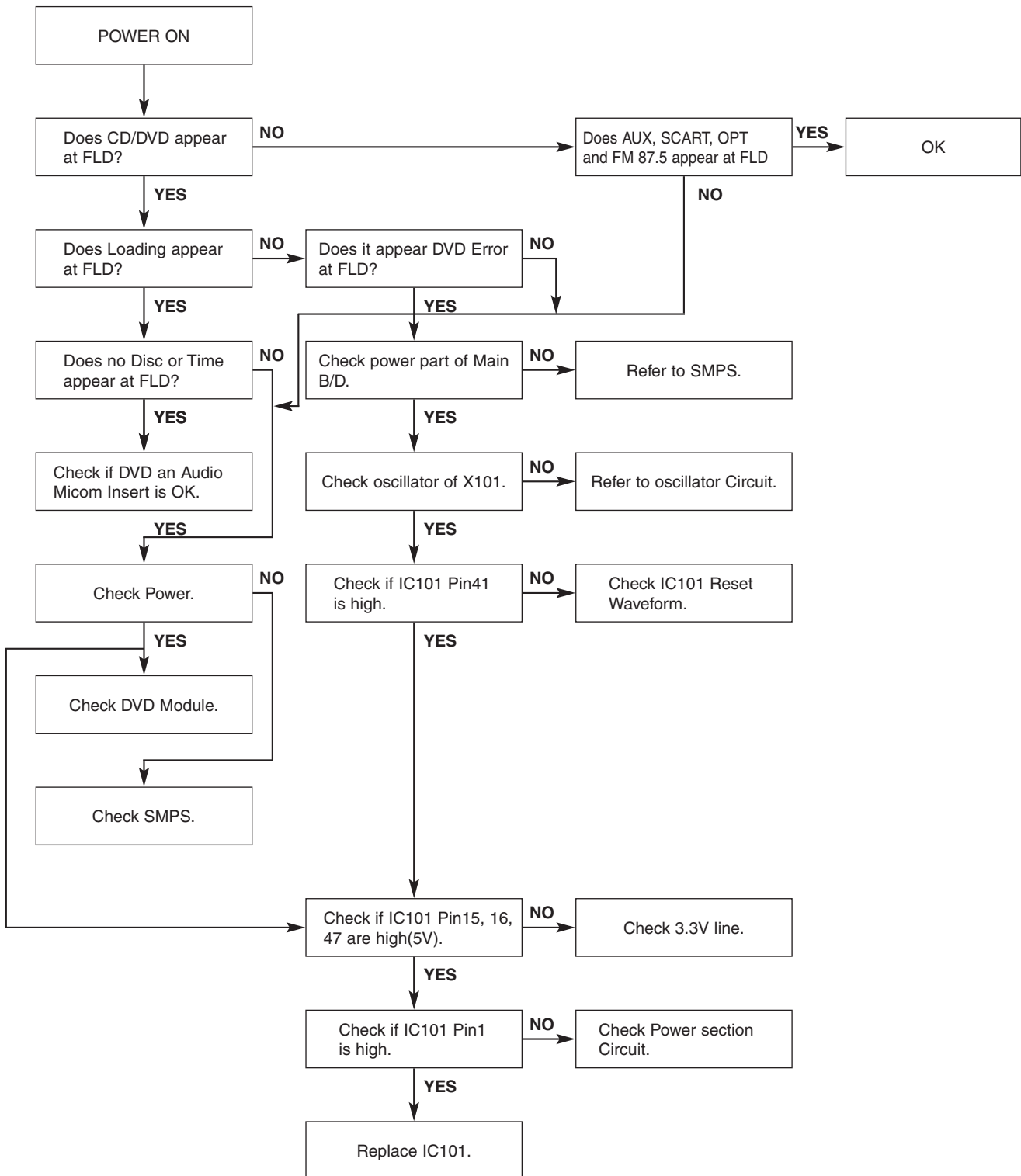








### 3. AUDIO $\mu$ -COM Circuit(DVD & AMP)



# DETAILS AND WAVEFORMS ON SYSTEM TEST AND DEBUGGING

## 1. SYSTEM 27MHz CLOCK,RESET,FLASH R/W SIGNAL

### 1) ES8380 main clock is at 27MHz(X501)

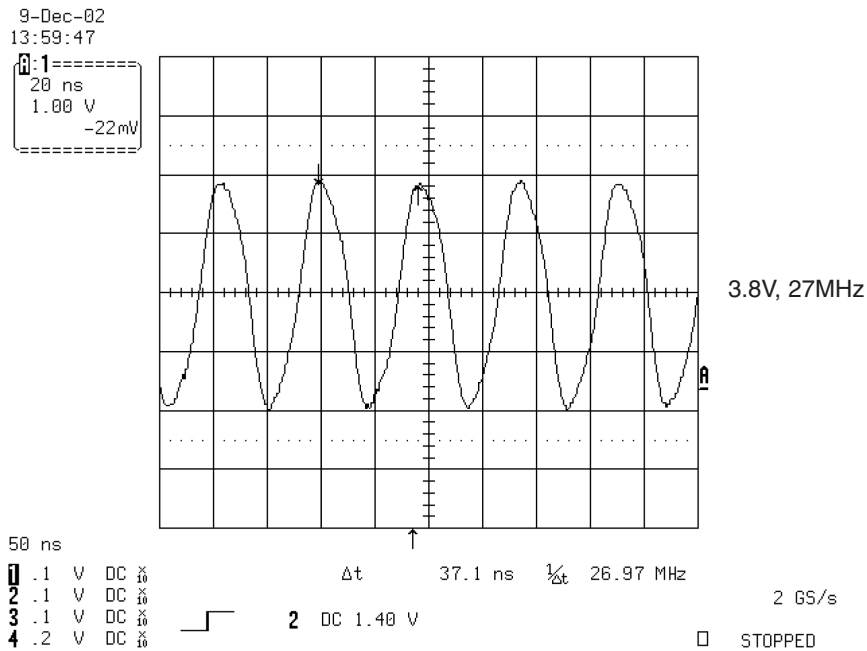


FIG 1-1

### 2) ES8380 reset is high active.

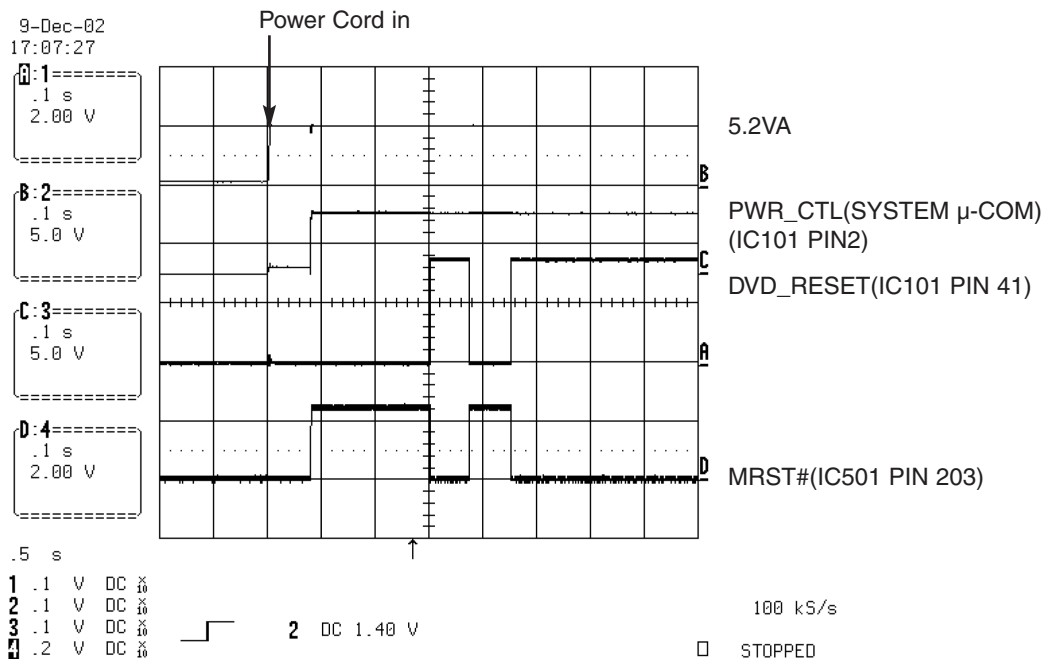


FIG 1-2

### 3) Flash R/W enable signal during download(Downloading)

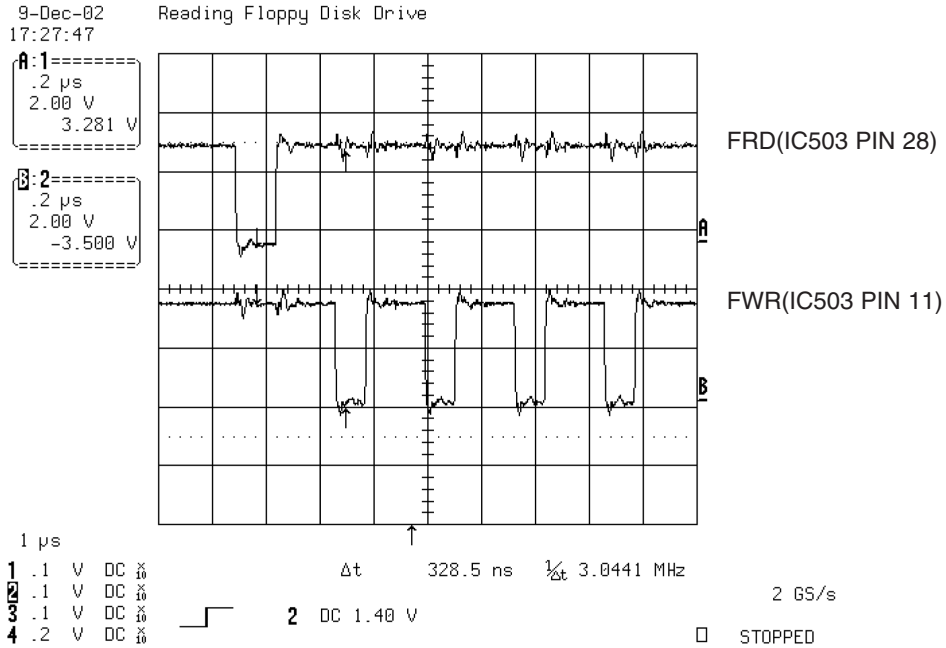


FIG 1-4

## 2. SDRAM CLOCK

### 1) ES8380 main clock is at 27MHz(X501)

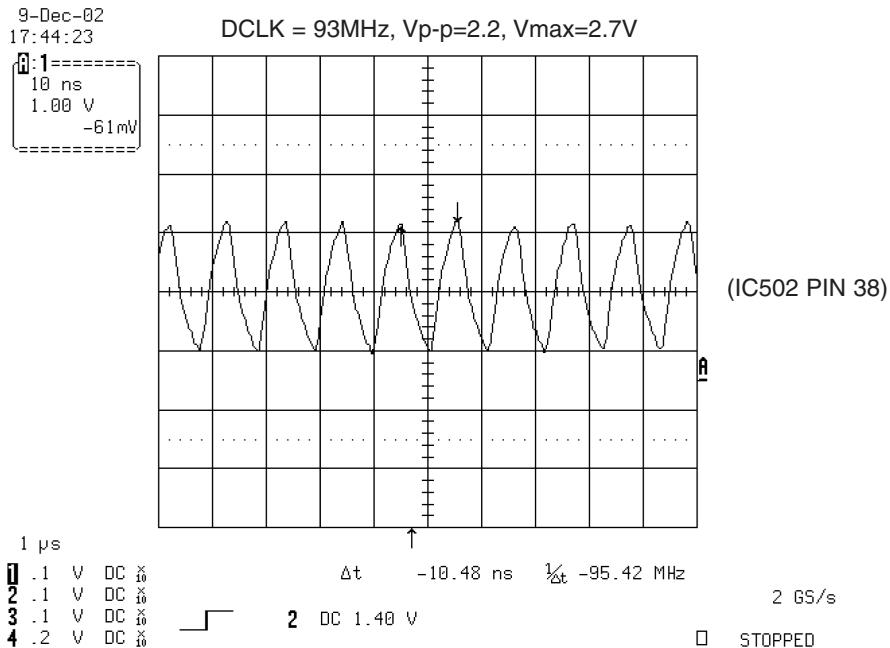


FIG 2-1

### 3. TRAY OPEN/CLOSE SIGNAL

#### 1) Tray open/close waveform

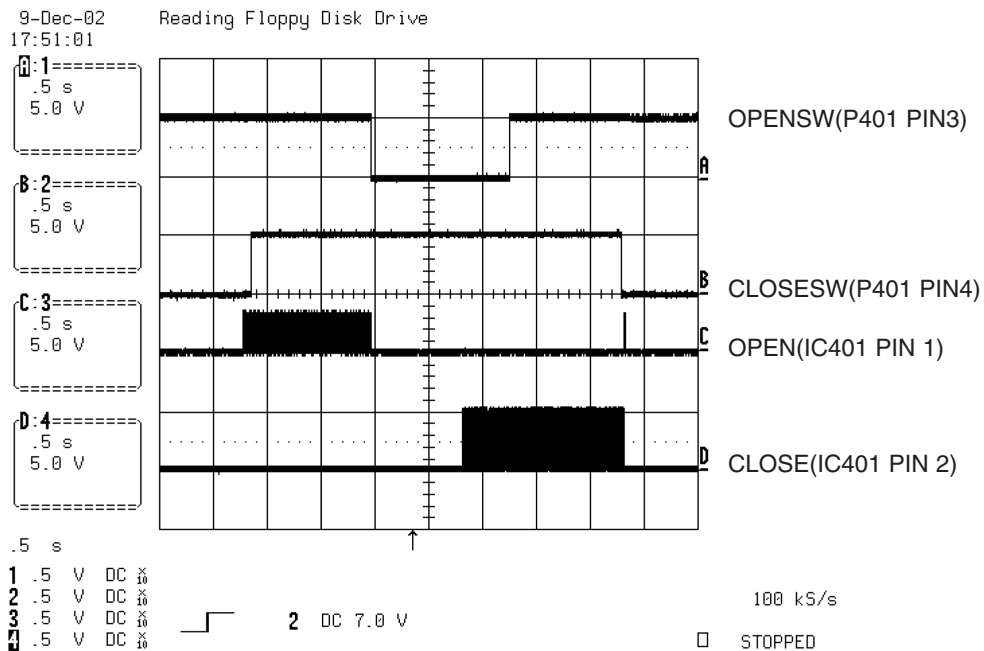


FIG 3-1

#### 2) Tray close waveform

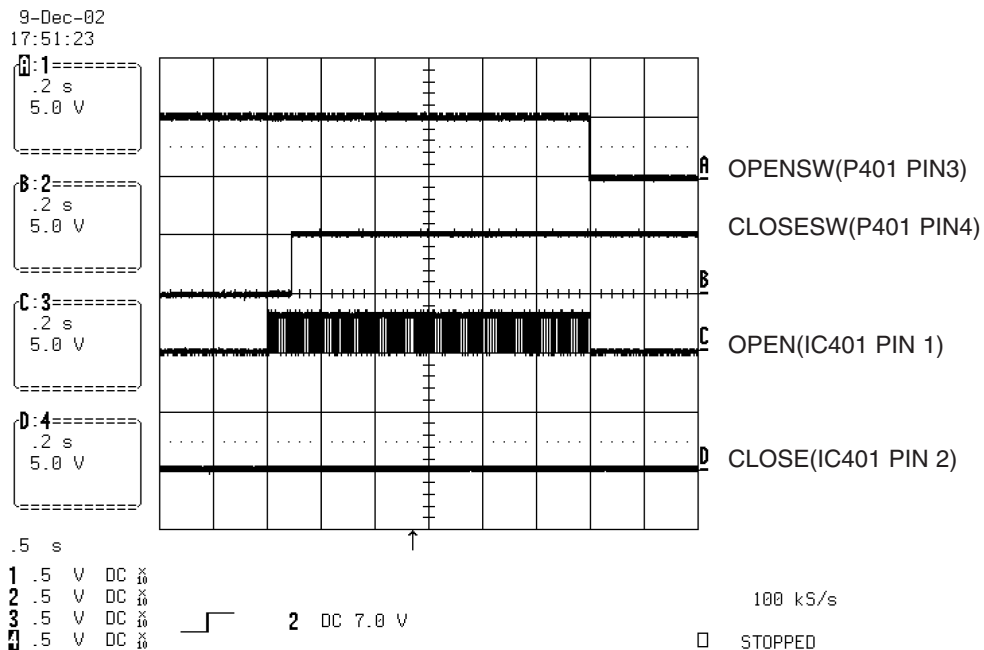


FIG 3-2

### 3) Tray open waveform

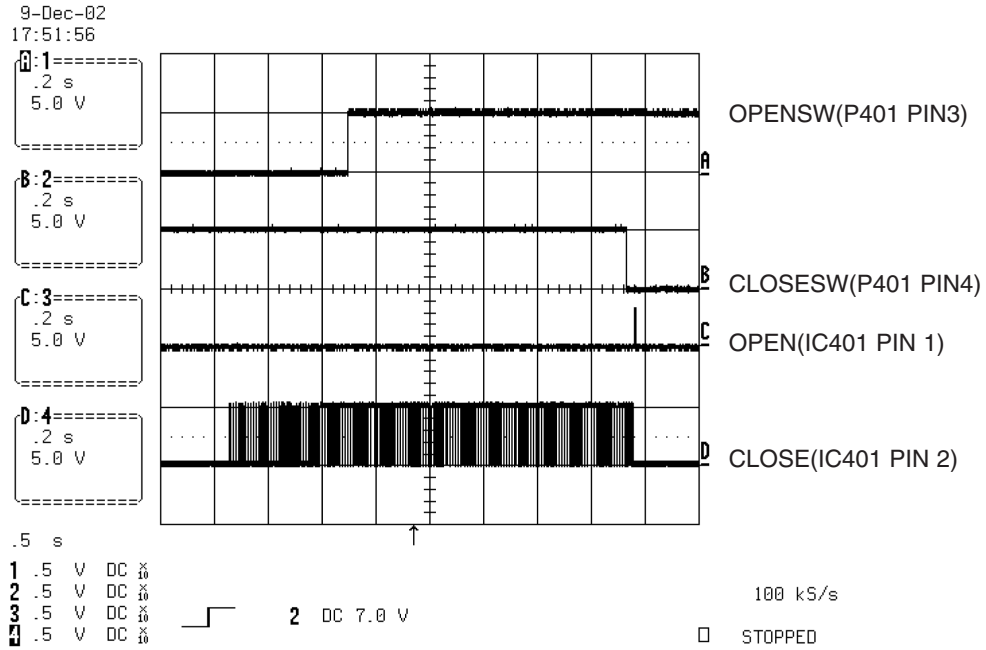


FIG 3-3

### 4. SLED CONTROL RELATED SIGNAL (NO DISC CONDITION)

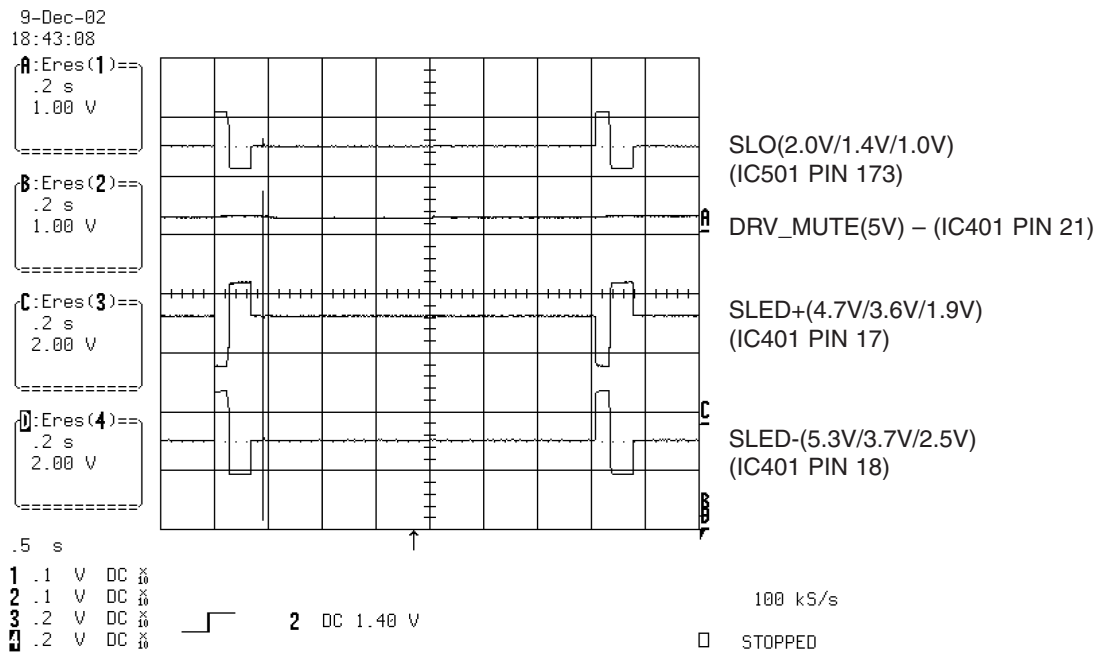


FIG 4-1

## 5. LENS CONTROL RELATED SIGNAL(NO DISC CONDITION)

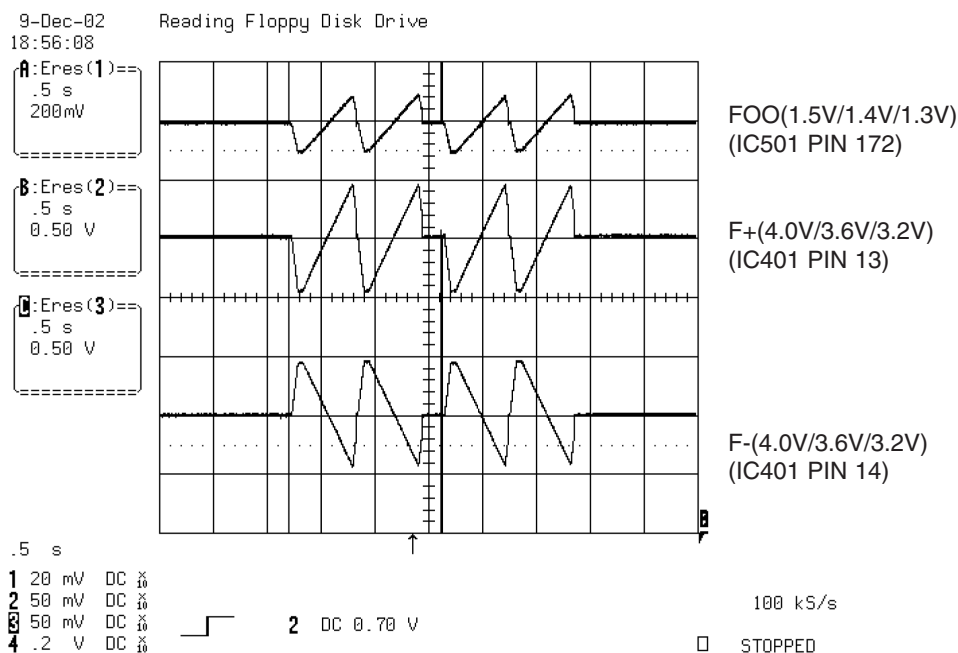


FIG 5-1

## 6. LASER POWER CONTROL RELATED SIGNAL(NO DISC CONDITION)

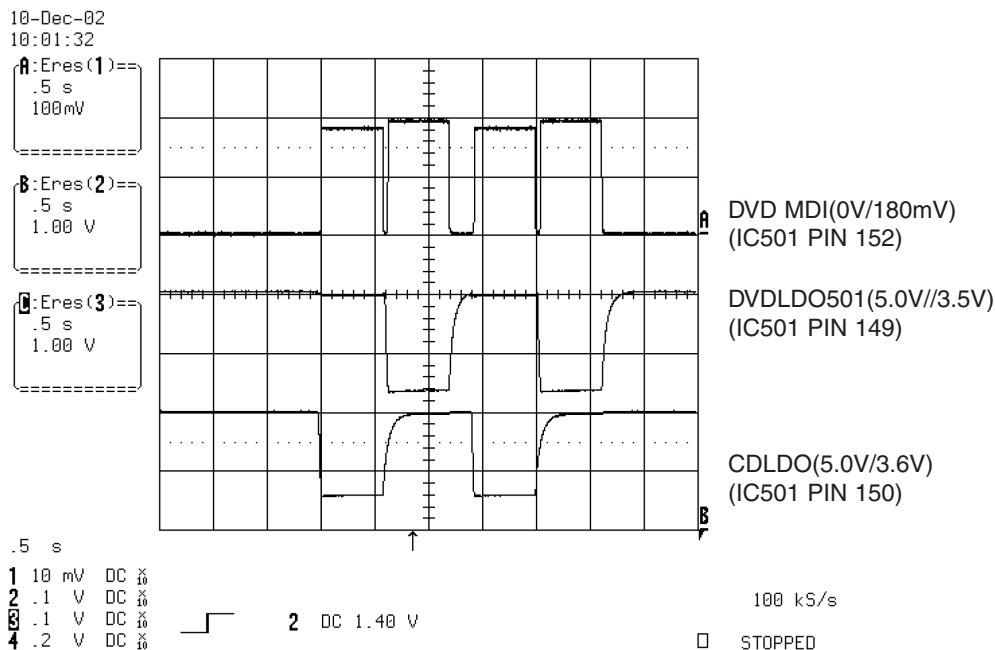


FIG 6-1



## 7. DISC TYPE JUDGEMENT WAVEFORMS

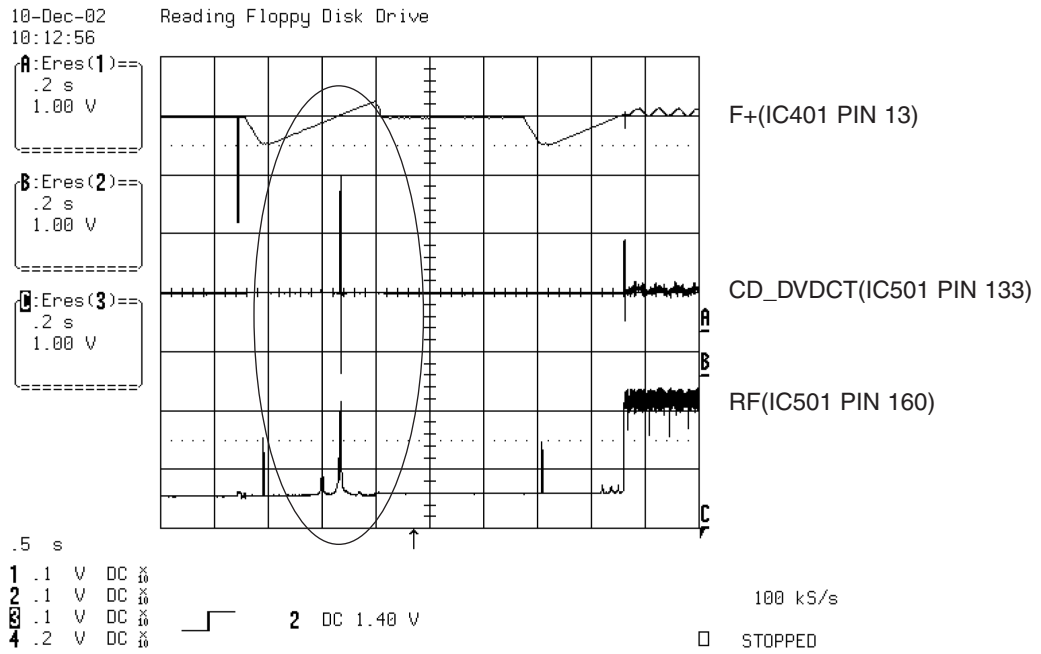


FIG 7-1 (DVD)

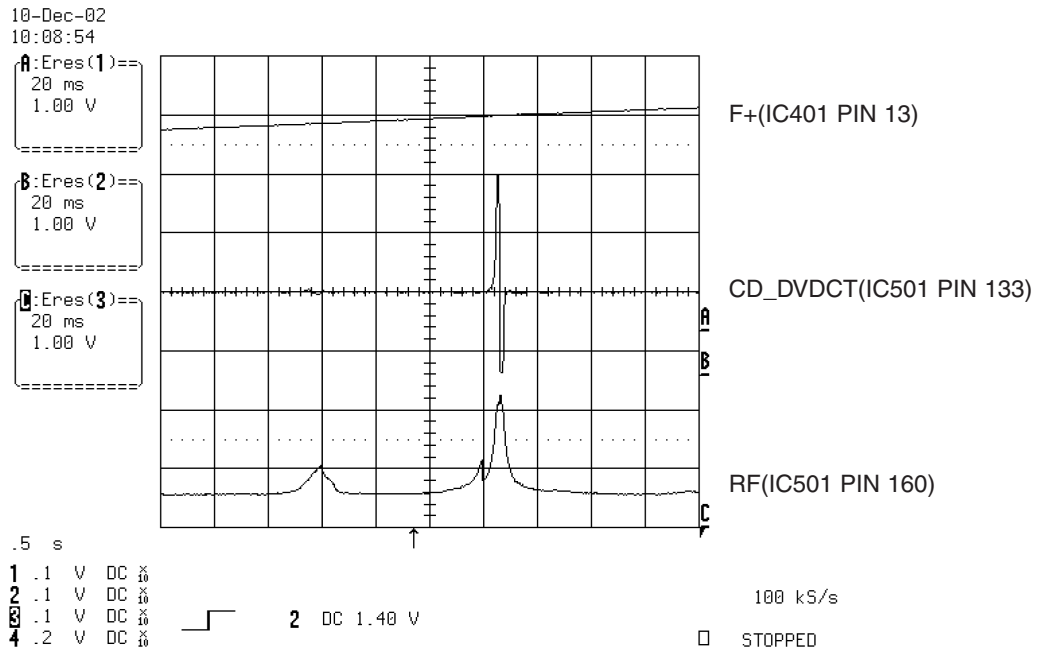


FIG 7-2 (DVD)

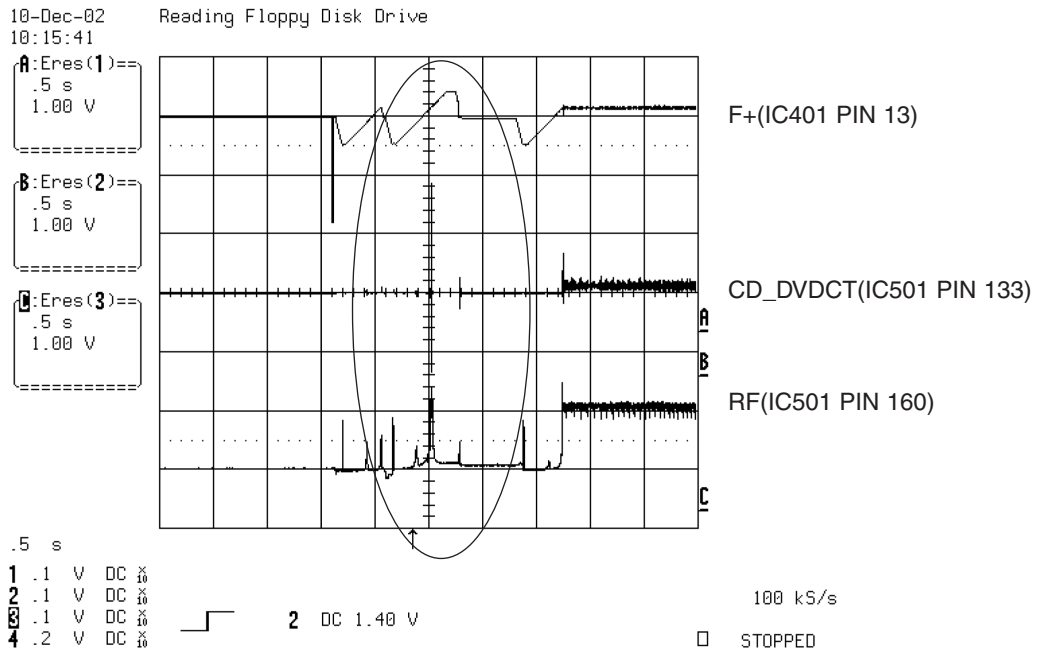


FIG 7-3 (CD)

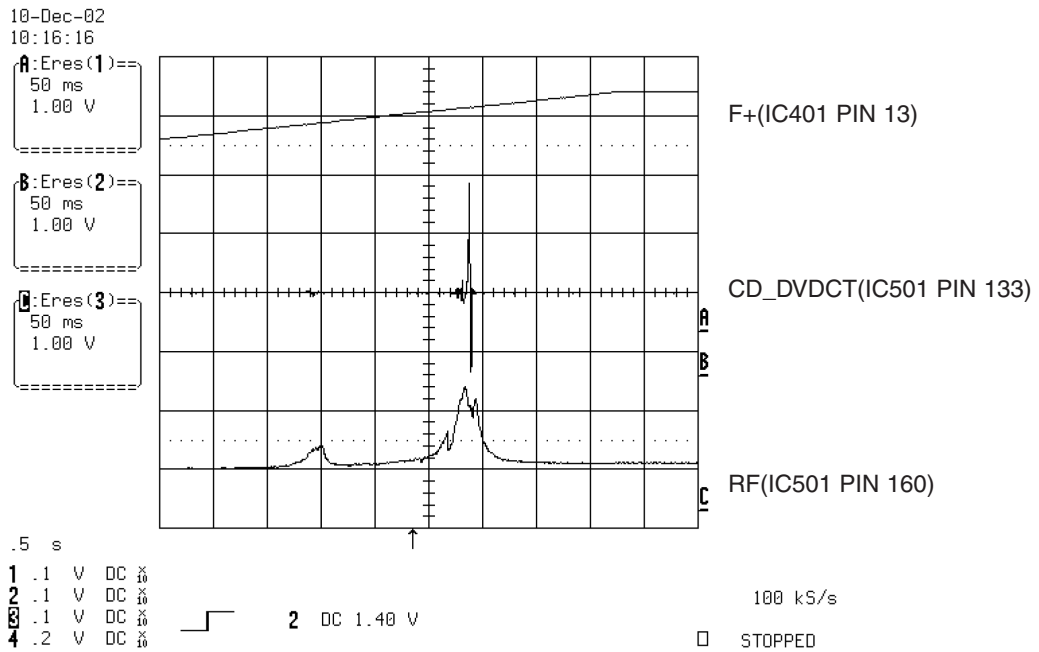


FIG 7-4 (CD)

## 8. FOCUS ON WAVEFORMS

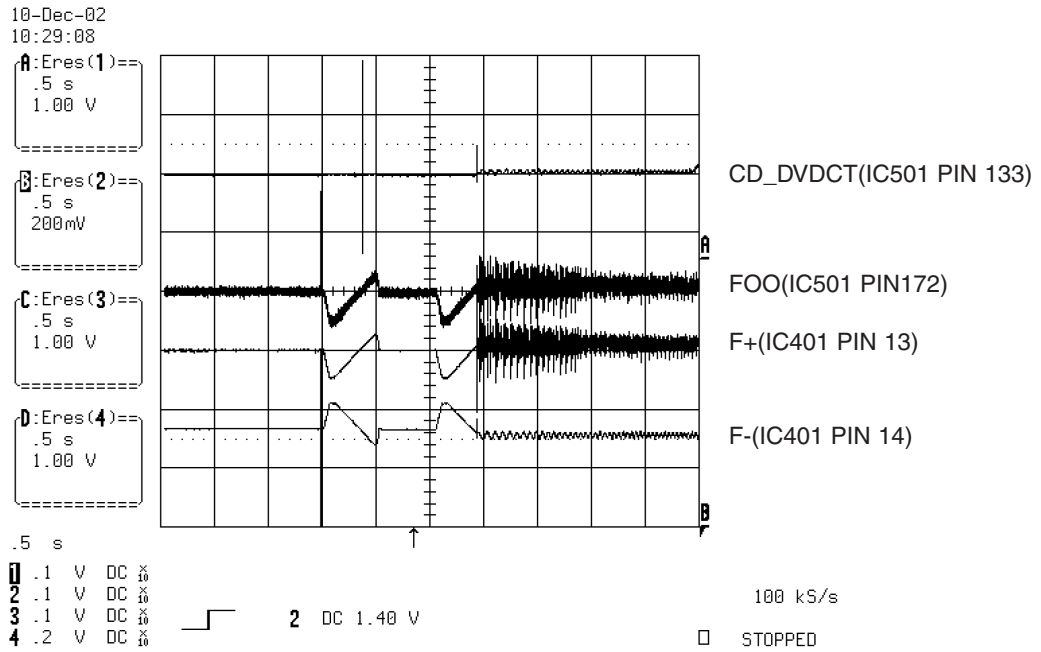


FIG 8-1 (DVD)

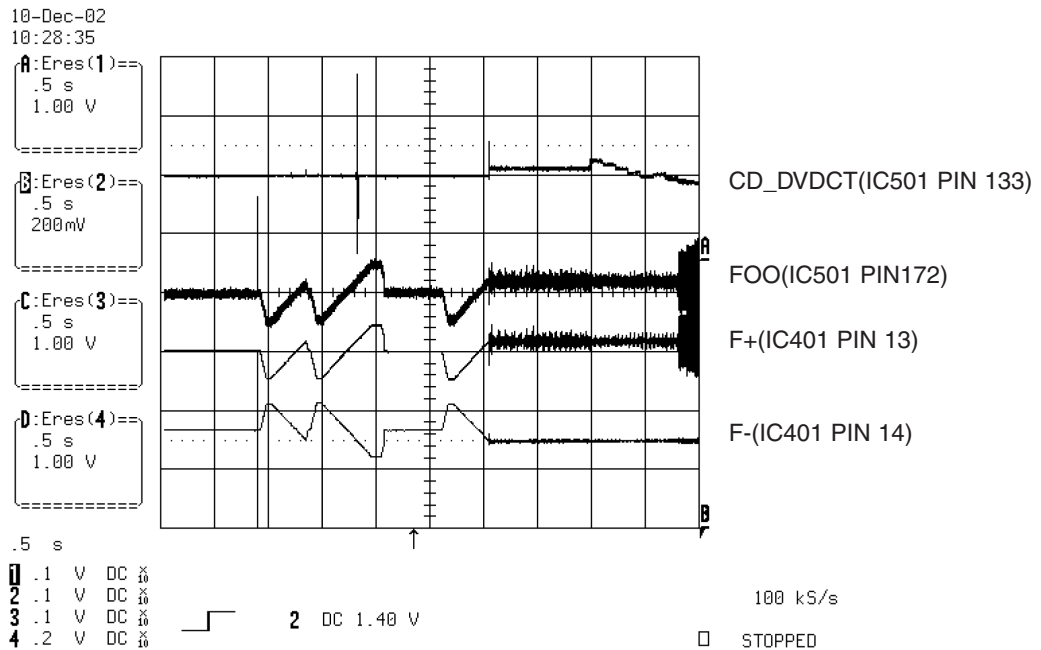


FIG 8-2 (CD)

## 9. SPINDLE CONTROL WAVEFORMS (NO DISC CONDITION)

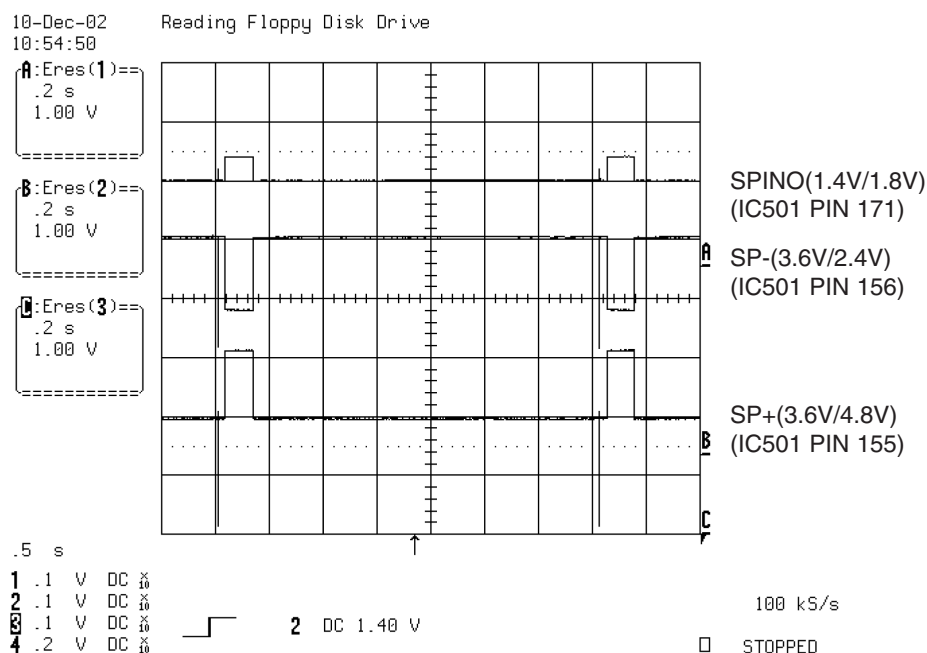


FIG 9-1

## 10. TRACKING CONTROL RELATED SIGNAL(System checking)

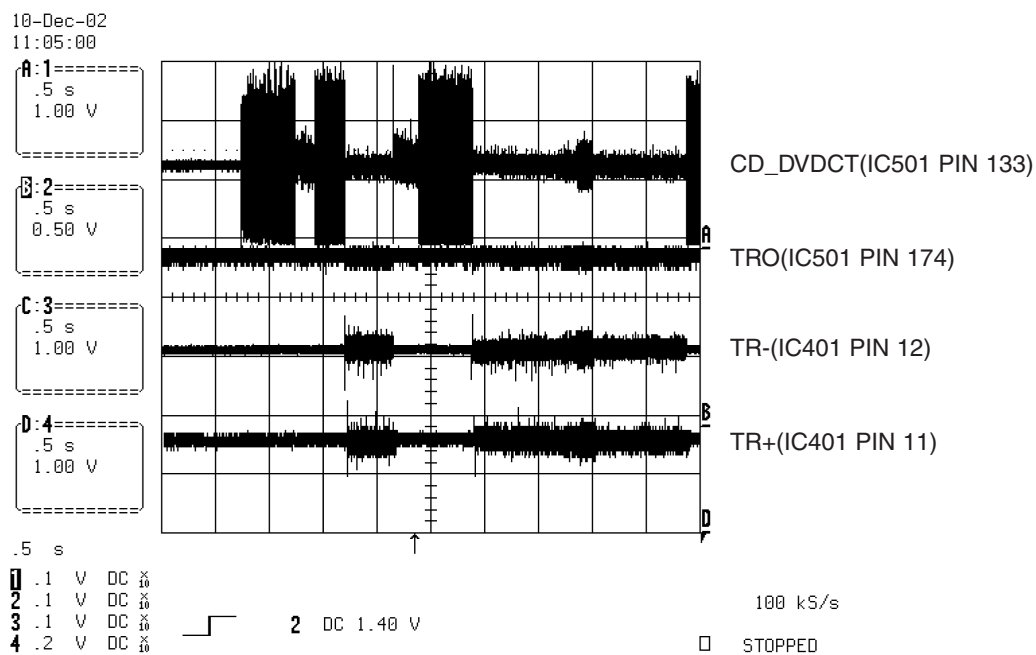


FIG 10-1(DVD)

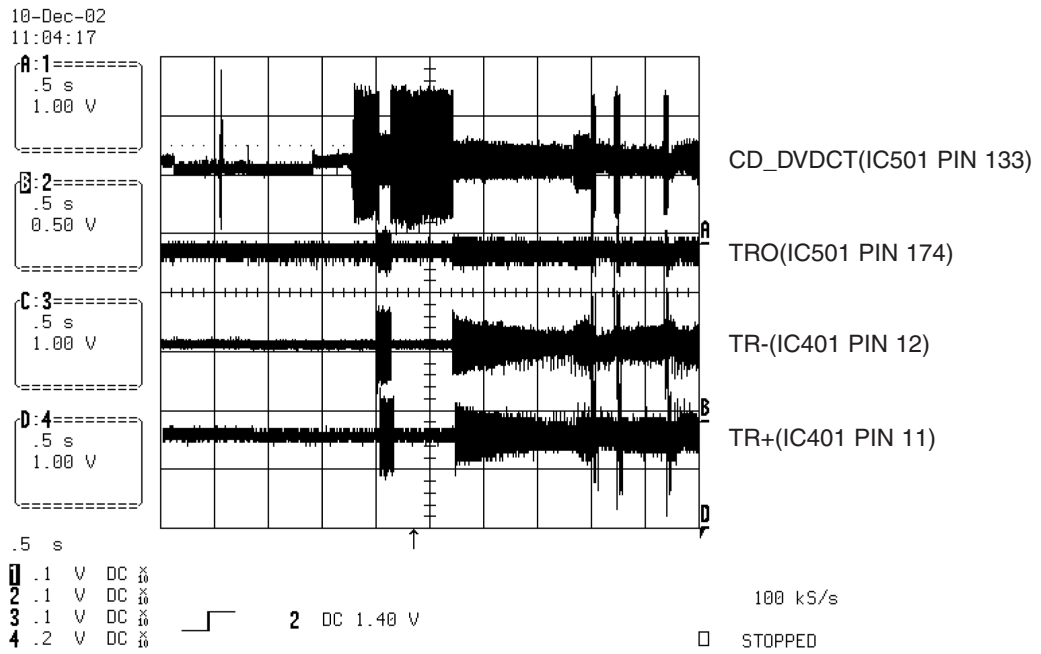


FIG 10-2(CD)

## 11. ES8380 VIDEO OUTPUT WAVEFORMS

### 1) Full colorbar signal(COMPOSIT)

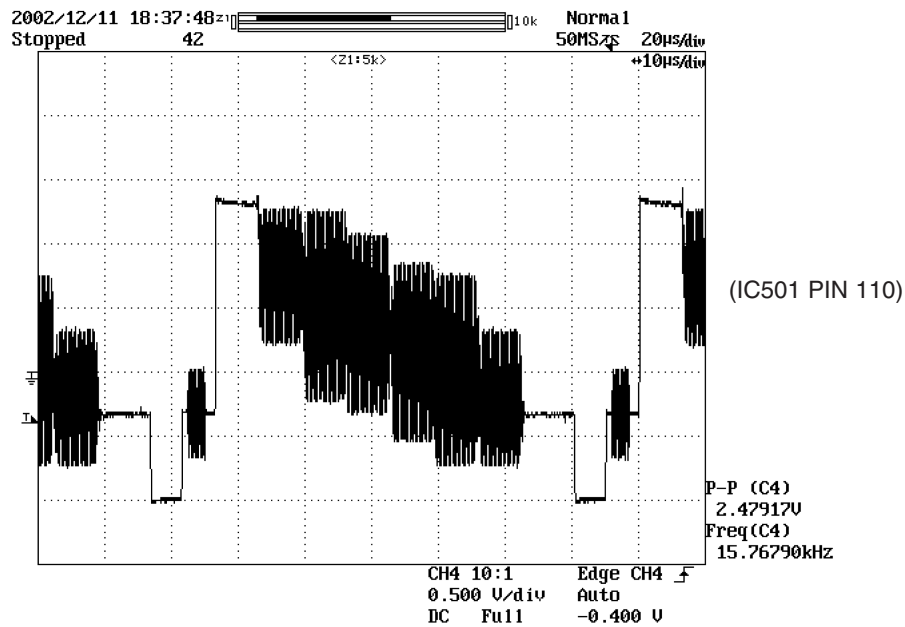


FIG 11-1

2) Y

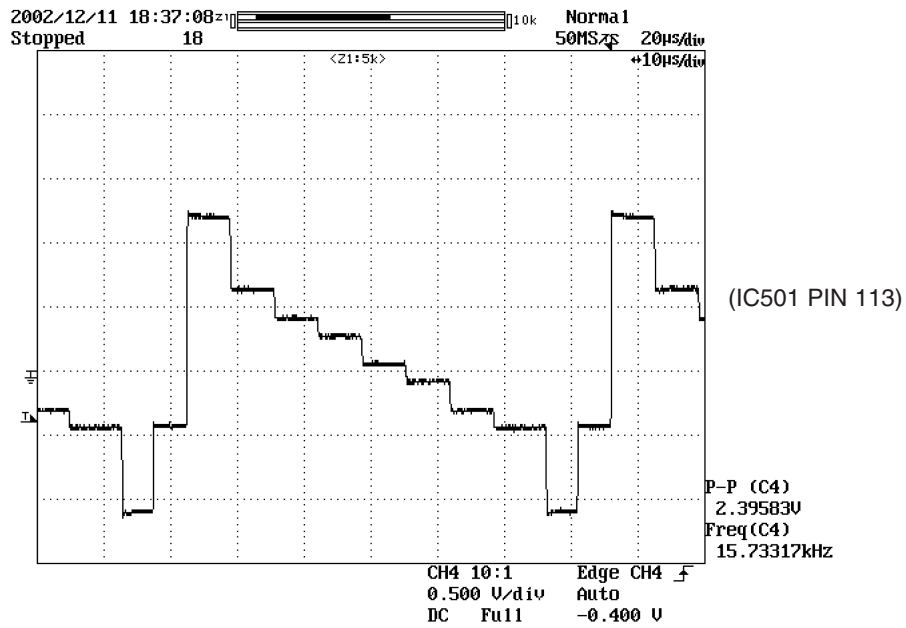


FIG 11-2

## 12. AUDIO OUTPUT FROM PWM IC

1) Audio L/R

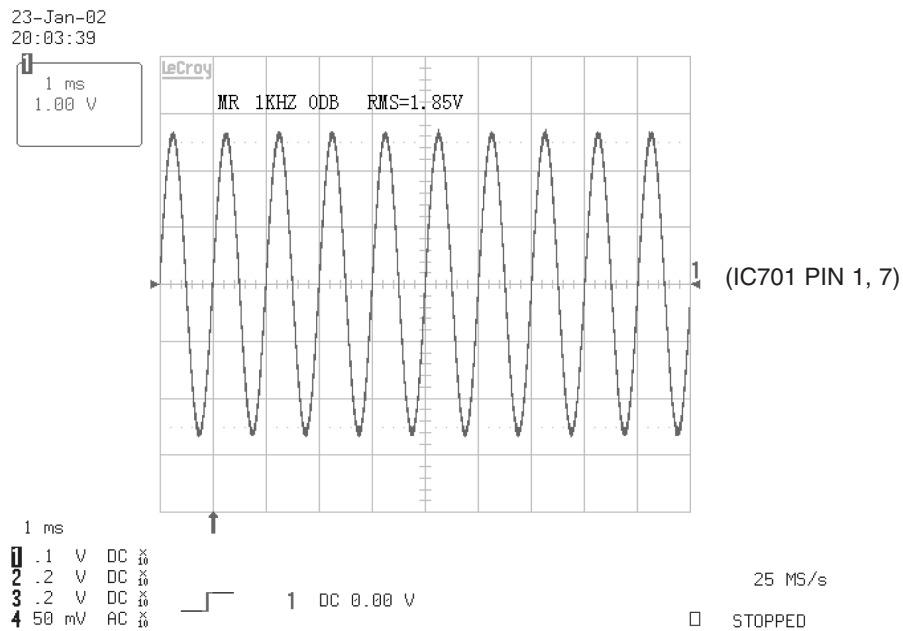


FIG 12-1

## 2) Audio related Signal

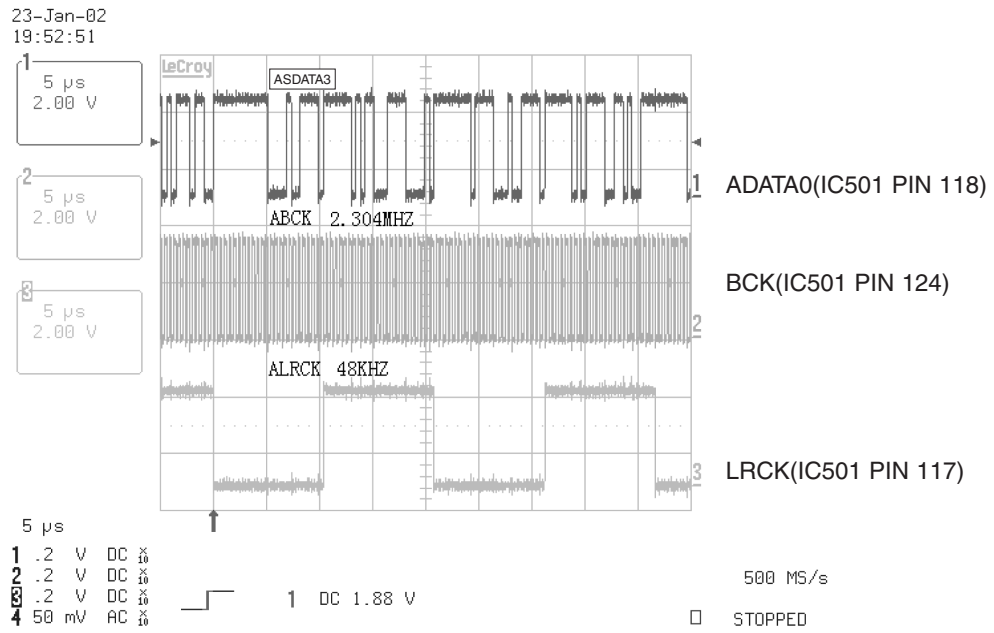
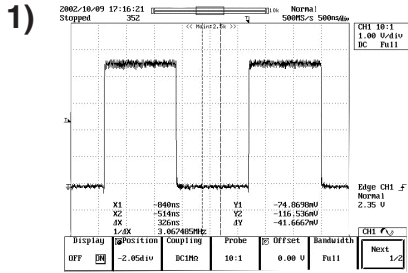
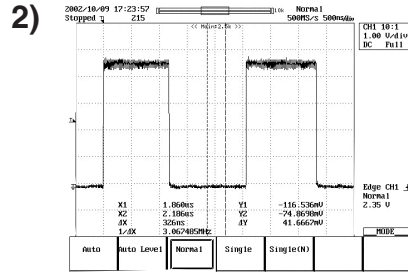


FIG 12-2

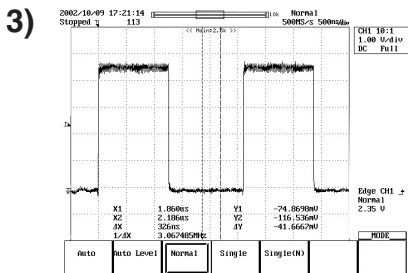
### 13. DVD & AMP WAVEFORMS



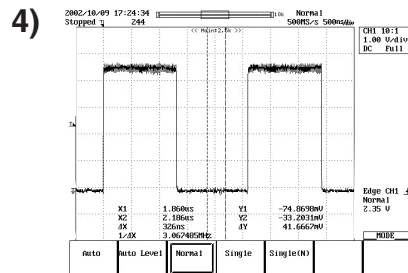
- R620 → TP611
- or
- R621 TP612



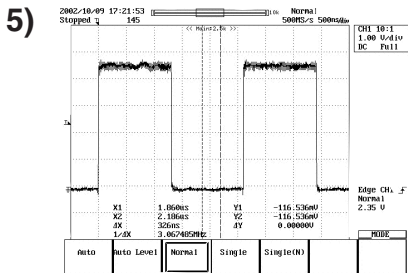
- R618 → TP609
- or
- R619 TP610



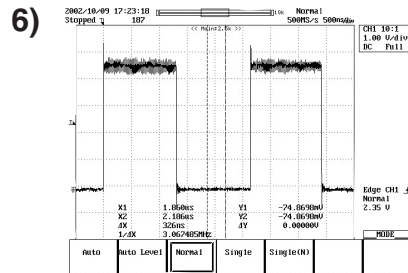
- R612 → TP603
- or
- R613 TP604



- R610 → TP601
- or
- R611 TP602



- R614 → TP605
- or
- R615 TP606



- R616 → TP607
- or
- R617 TP608



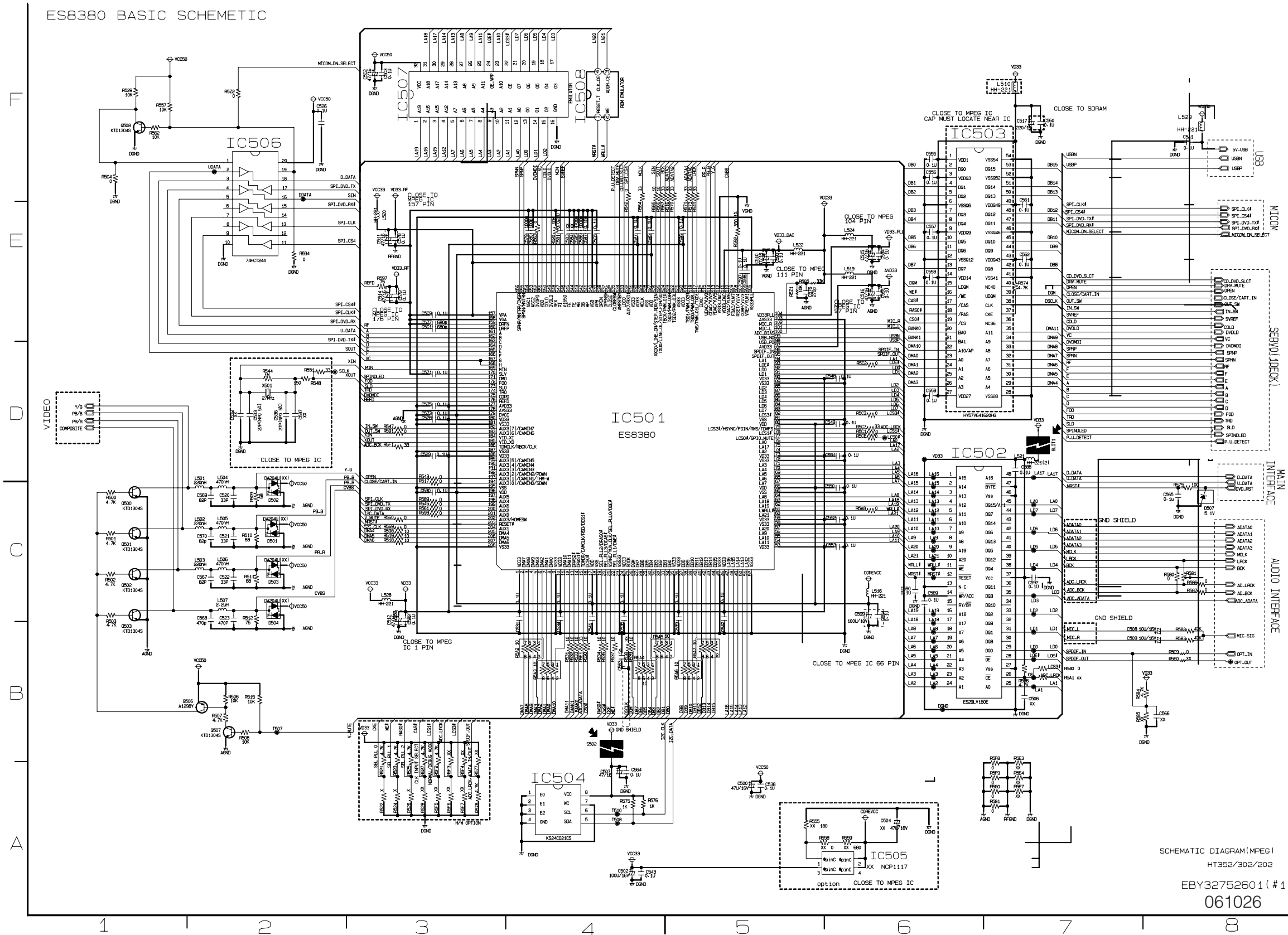
**MEMO**

A series of horizontal dotted lines provided for writing the memo content.

# DVD & AMP CIRCUIT DIAGRAM

## 1. MPEG CIRCUIT DIAGRAM

ES8380 BASIC SCHEMATIC



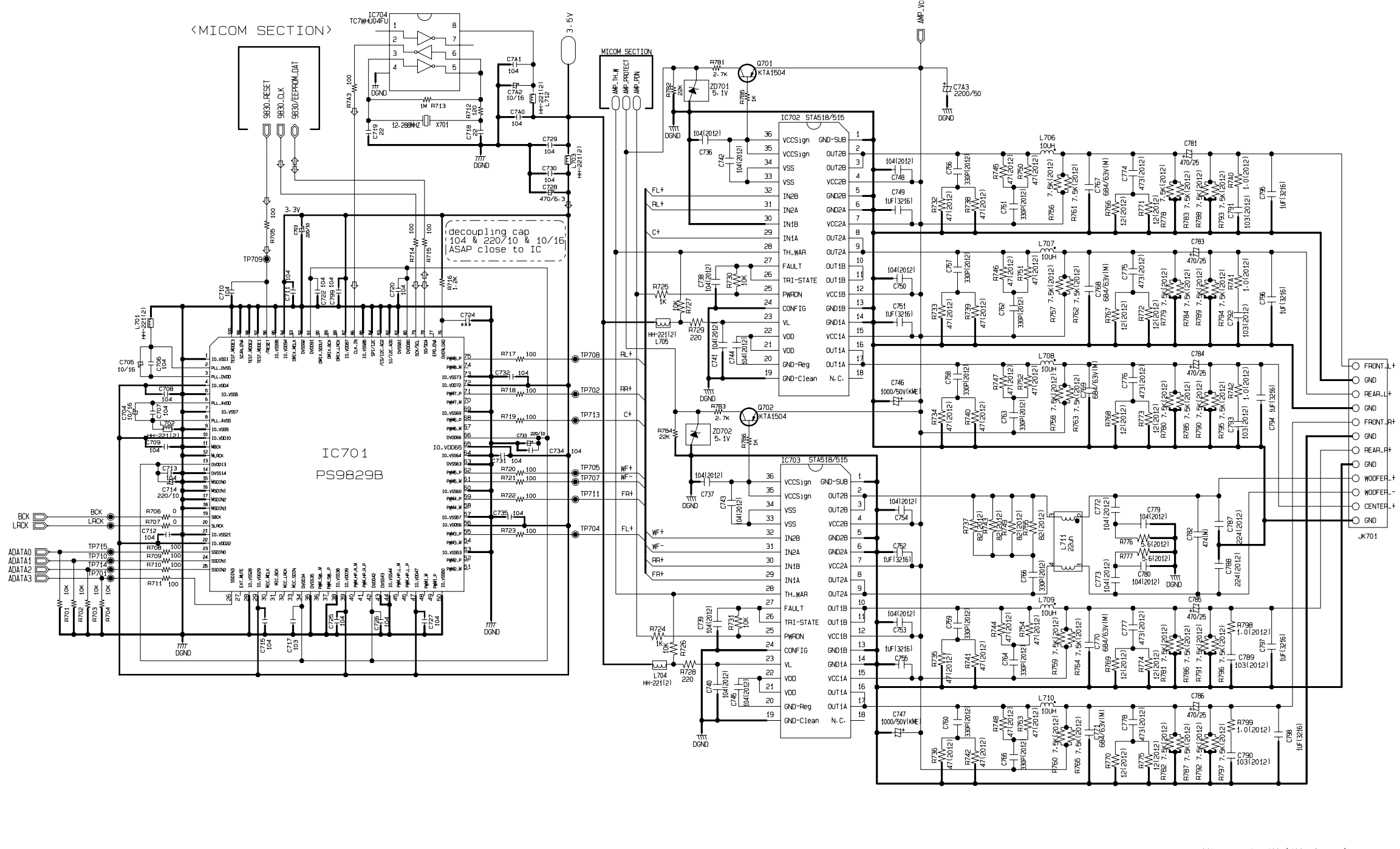
SCHEMATIC DIAGRAM(MPEG)  
HT352/302/202

EBY32752601 (#1)

061026

# 2. DSP & AMP CIRCUIT DIAGRAM

<< DSP+AMP SECTION >>



SCHEMATIC DIAGRAM (AMP + DSP)  
HT352/302/202  
EBY32752601 (#6)  
061026

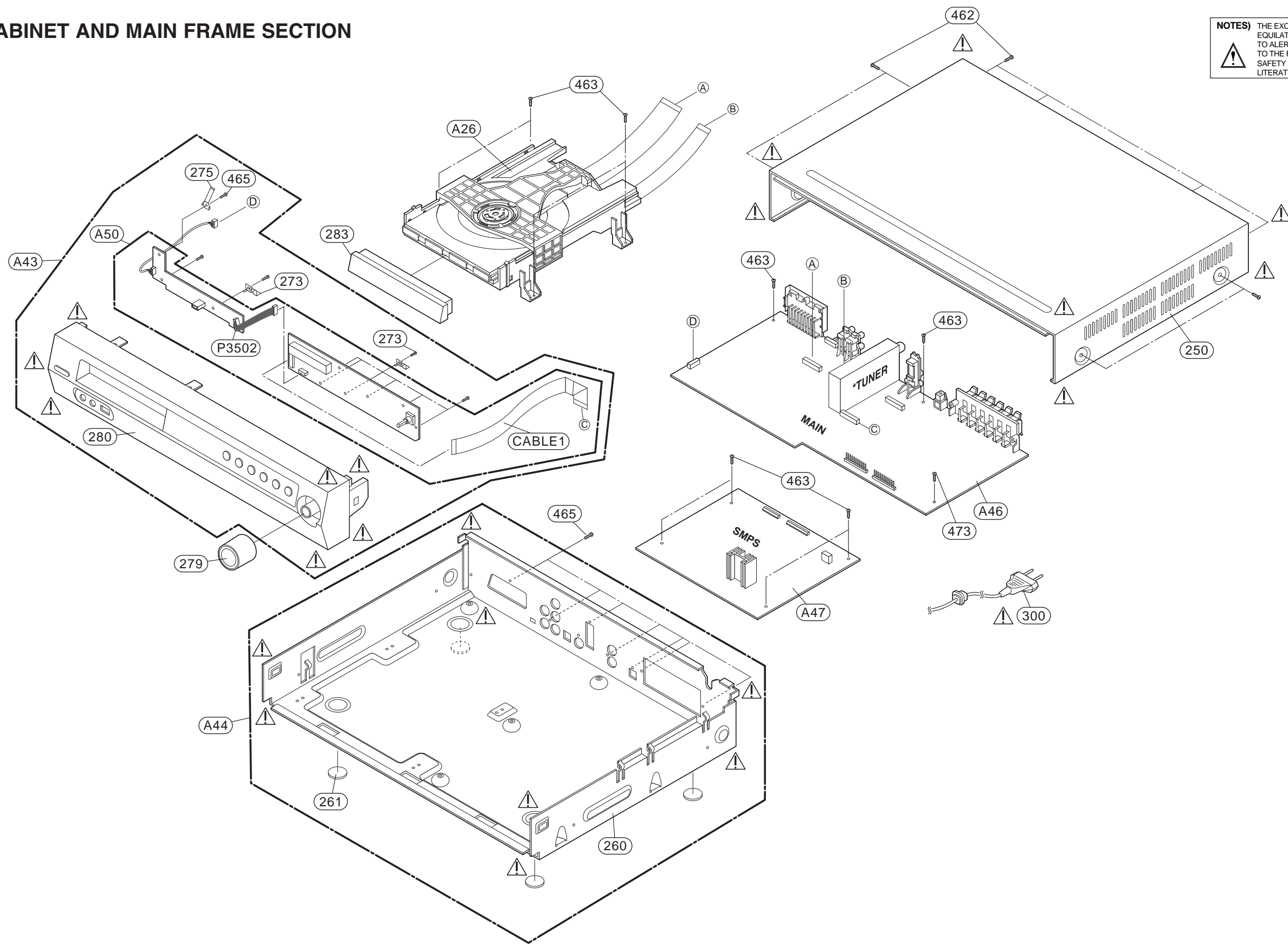
E  
D  
C  
B  
A

1 2 3 4 5 6 7 8

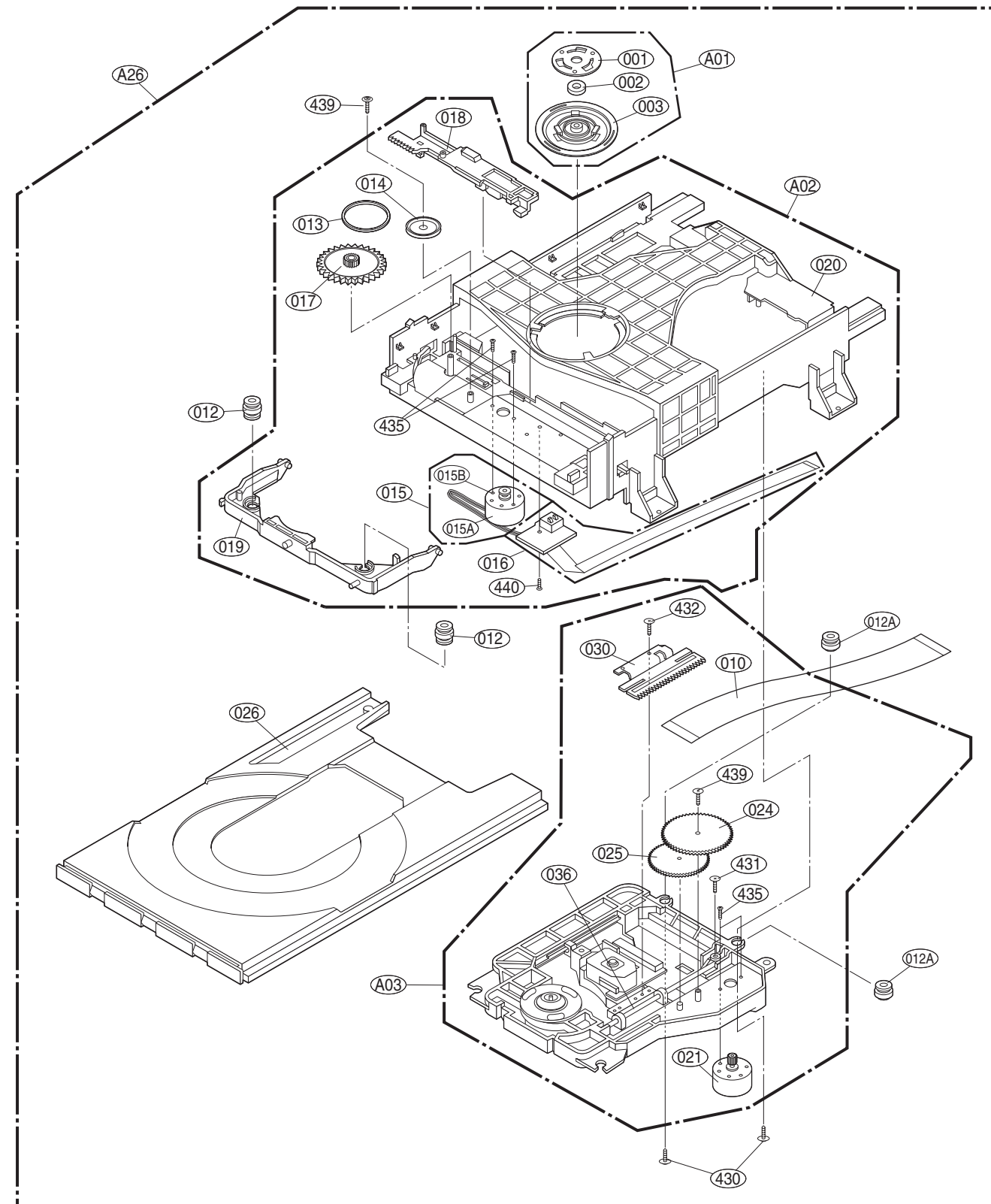
# SECTION 4. EXPLODED VIEWS

## • CABINET AND MAIN FRAME SECTION

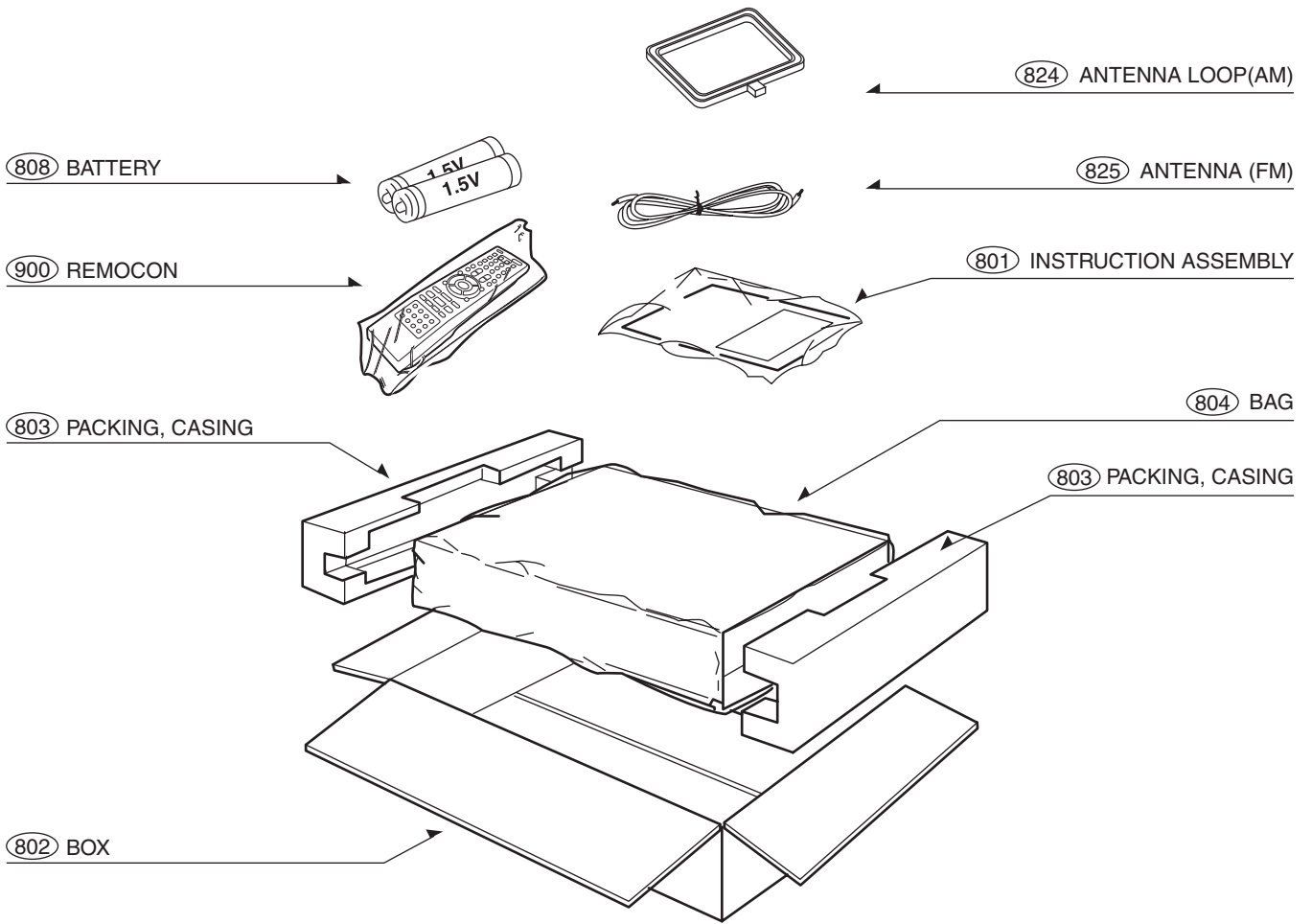
**NOTES)** THE EXCLAMATION POINT WITHIN AN EQUILATERAL TRIANGLE IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF IMPORTANT SAFETY INFORMATION IN SERVICE LITERATURE.



• DECK MECHANISM EXPLODED VIEW(DP-10T)

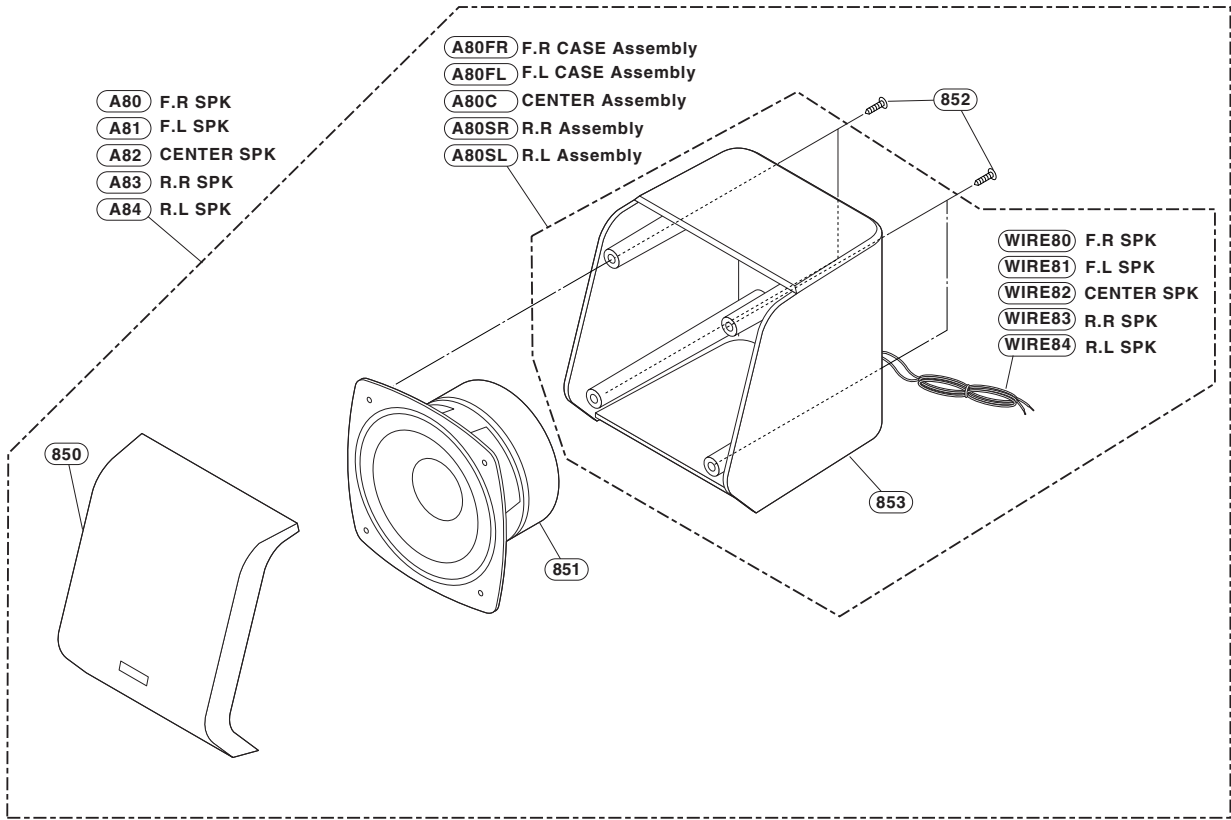


# • PACKING ACCESSORY SECTION

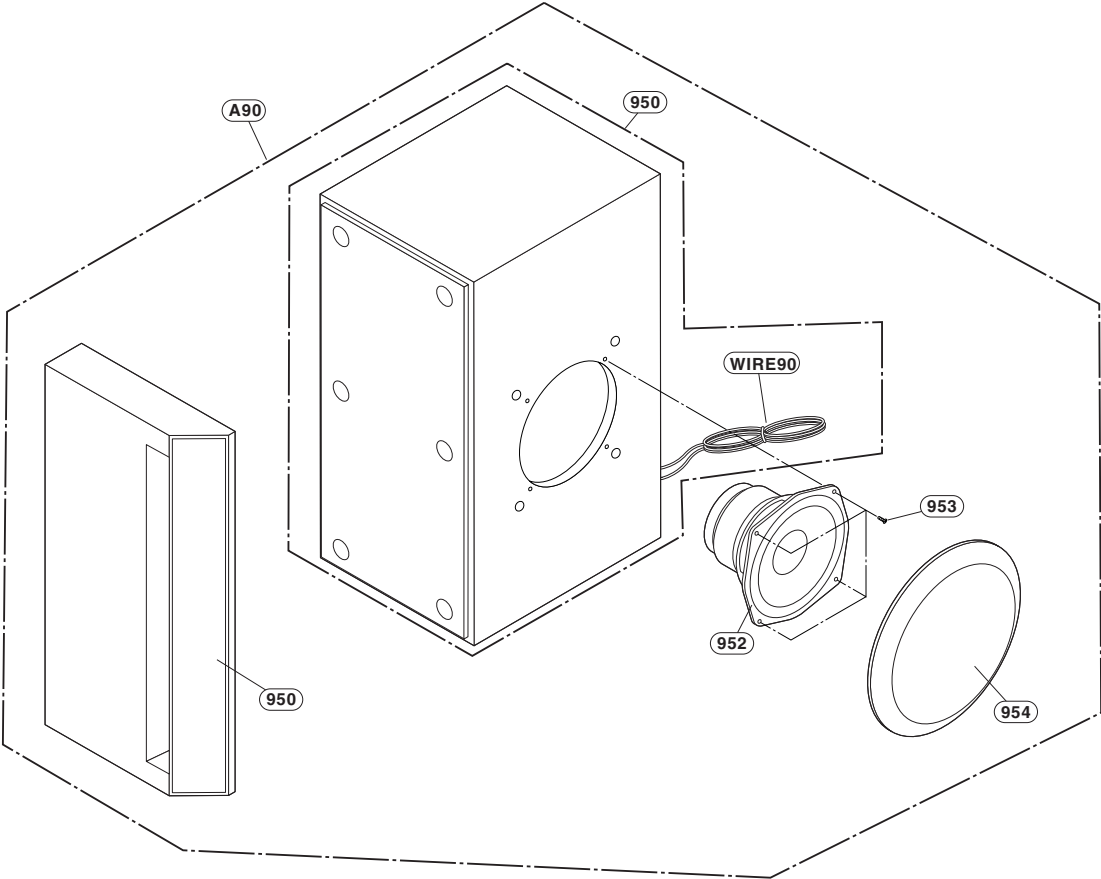


# SECTION 5. SPEAKER SECTION

## • FRONT/CENTER/REAR SPEAKER (SH32SD-S)



• PASSIVE SUBWOOFER SPEAKER (SH32SD-W)





# MEMO

A series of horizontal dotted lines for writing.